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The original manufacturer datasheet follows from the next page.

TMS320DM643

Video/Imaging Fixed-Point Digital Signal Processor

Check for Samples: [TMS320DM643](#)

1 TMS320DM643 Video/Imaging Fixed-Point Digital Signal Processor

- **High-Performance Digital Media Processor**
 - 2-, 1.67-ns Instruction Cycle Time
 - 500-, 600-MHz Clock Rate
 - Eight 32-Bit Instructions/Cycle
 - 4000, 4800 MIPS
 - Fully Software-Compatible With C64x™
- **VelociTI.2™ Extensions to VelociTI™ Advanced Very-Long-Instruction-Word (VLIW) TMS320C64x™ DSP Core**
 - Eight Highly Independent Functional Units With VelociTI.2™ Extensions:
 - Six ALUs (32-/40-Bit), Each Supports Single 32-Bit, Dual 16-Bit, or Quad 8-Bit Arithmetic per Clock Cycle
 - Two Multipliers Support Four 16 x 16-Bit Multiplies (32-Bit Results) per Clock Cycle or Eight 8 x 8-Bit Multiplies (16-Bit Results) per Clock Cycle
 - Load-Store Architecture With Non-Aligned Support
 - 64 32-Bit General-Purpose Registers
 - Instruction Packing Reduces Code Size
 - All Instructions Conditional
- **Instruction Set Features**
 - Byte-Addressable (8-/16-/32-/64-Bit Data)
 - 8-Bit Overflow Protection
 - Bit-Field Extract, Set, Clear
 - Normalization, Saturation, Bit-Counting
 - VelociTI.2™ Increased Orthogonality
- **L1/L2 Memory Architecture**
 - 128K-Bit (16K-Byte) L1P Program Cache (Direct Mapped)
 - 128K-Bit (16K-Byte) L1D Data Cache (2-Way Set-Associative)
 - 2M-Bit (256K-Byte) L2 Unified Mapped RAM/Cache (Flexible RAM/Cache Allocation)
- **Endianess: Little Endian, Big Endian**
- **64-Bit External Memory Interface (EMIF)**
 - Glueless Interface to Asynchronous Memories (SRAM and EPROM) and Synchronous Memories (SDRAM, SBSRAM, ZBT SRAM, and FIFO)
- **Enhanced Direct-Memory-Access (EDMA) Controller (64 Independent Channels)**
- **10/100 Mb/s Ethernet MAC (EMAC)**
 - IEEE 802.3 Compliant
 - Media Independent Interface (MII)
 - 8 Independent Transmit (TX) Channels and 1 Receive (RX) Channel
- **Management Data Input/Output (MDIO)**
- **Two Configurable Video Ports (VP1, VP2)**
 - Providing a Glueless I/F to Common Video Decoder and Encoder Devices
 - Supports Multiple Resolutions/Video Stds
- **VCXO Interpolated Control Port (VIC)**
 - Supports Audio/Video Synchronization
- **Host-Port Interface (HPI) [32-/16-Bit]**
- **Multichannel Audio Serial Port (McASP)**
 - Eight Serial Data Pins
 - Wide Variety of I²S and Similar Bit Stream Format
 - Integrated Digital Audio I/F Transmitter Supports S/PDIF, IEC60958-1, AES-3, CP-430 Formats
- **Inter-Integrated Circuit (I²C Bus™)**
- **Multichannel Buffered Serial Port**
 - CLKS Input Not Supported
- **Three 32-Bit General-Purpose Timers**
- **Sixteen General-Purpose I/O (GPIO) Pins**
- **Flexible PLL Clock Generator**
- **IEEE-1149.1 (JTAG) Boundary-Scan-Compatible**
- **548-Pin Ball Grid Array (BGA) Package (GDK and ZDK Suffixes), 0.8-mm Ball Pitch**
- **548-Pin Ball Grid Array (BGA) Package (GNZ and ZNZ Suffixes), 1.0-mm Ball Pitch**
- **0.13-µm/6-Level Cu Metal Process (CMOS)**
- **3.3-V I/O, 1.2-V Internal (-500)**
- **3.3-V I/O, 1.4-V Internal (-600)**



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The TMS320C64x™ DSPs (including the TMS320DM643 device) are the highest-performance fixed-point DSP generation in the TMS320C6000™ DSP platform. The TMS320DM643 (DM643) device is based on the second-generation high-performance, advanced VelociTI™ very-long-instruction-word (VLIW) architecture (VelociTI.2™) developed by Texas Instruments (TI), making these DSPs an excellent choice for digital media applications. The C64x™ is a code-compatible member of the C6000™ DSP platform.

With performance of up to 4800 million instructions per second (MIPS) at a clock rate of 600 MHz, the DM643 device offers cost-effective solutions to high-performance DSP programming challenges. The DM643 DSP possesses the operational flexibility of high-speed controllers and the numerical capability of array processors. The C64x™ DSP core processor has 64 general-purpose registers of 32-bit word length and eight highly independent functional units—two multipliers for a 32-bit result and six arithmetic logic units (ALUs)—with VelociTI.2™ extensions. The VelociTI.2™ extensions in the eight functional units include new instructions to accelerate the performance in video and imaging applications and extend the parallelism of the VelociTI™ architecture. The DM643 can produce four 16-bit multiply-accumulates (MACs) per cycle for a total of 2400 million MACs per second (MMACS), or eight 8-bit MACs per cycle for a total of 4800 MMACS. The DM643 DSP also has application-specific hardware logic, on-chip memory, and additional on-chip peripherals similar to the other C6000™ DSP platform devices.

The DM643 uses a two-level cache-based architecture and has a powerful and diverse set of peripherals. The Level 1 program cache (L1P) is a 128-Kbit direct mapped cache and the Level 1 data cache (L1D) is a 128-Kbit 2-way set-associative cache. The Level 2 memory/cache (L2) consists of an 2-Mbit memory space that is shared between program and data space. L2 memory can be configured as mapped memory, cache, or combinations of the two. The peripheral set includes: two configurable video ports; a 10/100 Mb/s Ethernet MAC (EMAC); a management data input/output (MDIO) module; a VCXO interpolated control port (VIC); one multichannel buffered audio serial port (McASP0); an inter-integrated circuit (I2C) Bus module; one multichannel buffered serial port (McBSP); three 32-bit general-purpose timers; a user-configurable 16-bit or 32-bit host-port interface (HPI16/HPI32); a 16-pin general-purpose input/output port (GP0) with programmable interrupt/event generation modes; and a 64-bit glueless external memory interface (EMIFA), which is capable of interfacing to synchronous and asynchronous memories and peripherals.

The DM643 device has two configurable video port peripherals (VP1 and VP2). These video port peripherals provide a glueless interface to common video decoder and encoder devices. The DM643 video port peripherals support multiple resolutions and video standards (e.g., CCIR601, ITU-BT.656, BT.1120, SMPTE 125M, 260M, 274M, and 296M).

These two video port peripherals are configurable and can support either video capture and/or video display modes. Each video port consists of two channels — A and B with a 5120-byte capture/display buffer that is splittable between the two channels.

For more details on the Video Port peripherals, see the *TMS320C64x DSP Video Port/VCXO Interpolated Control (VIC) Port Reference Guide* (literature number SPRU629).

The McASP0 port supports one transmit and one receive clock zone, with eight serial data pins which can be individually allocated to any of the two zones. The serial port supports time-division multiplexing on each pin from 2 to 32 time slots. The DM643 has sufficient bandwidth to support all 8 serial data pins transmitting a 192-kHz stereo signal. Serial data in each zone may be transmitted and received on multiple serial data pins simultaneously and formatted in a multitude of variations on the Philips Inter-IC Sound (I²S) format.

In addition, the McASP0 transmitter may be programmed to output multiple S/PDIF, IEC60958, AES-3, CP-430 encoded data channels simultaneously, with a single RAM containing the full implementation of user data and channel status fields.

McASP0 also provides extensive error-checking and recovery features, such as the bad clock detection circuit for each high-frequency master clock which verifies that the master clock is within a programmed frequency range.

The VCXO interpolated control (VIC) port provides digital-to-analog conversion with resolution from 9-bits to up to 16-bits. The output of the VIC is a single bit interpolated D/A output. For more details on the VIC port, see the *TMS320C64x DSP Video Port/VCXO Interpolated Control (VIC) Port Reference Guide* (literature number SPRU629).

The ethernet media access controller (EMAC) provides an efficient interface between the DM643 DSP core processor and the network. The DM643 EMAC support both 10Base-T and 100Base-TX, or 10 Mbits/second (Mbps) and 100 Mbps in either half- or full-duplex, with hardware flow control and quality of service (QOS) support. The DM643 EMAC makes use of a custom interface to the DSP core that allows efficient data transmission and reception. For more details on the EMAC, see the *TMS320C6000 DSP Ethernet Media Access Controller (EMAC) / Management Data Input/Output (MDIO) Module Reference Guide* (literature number SPRU628).

The management data input/output (MDIO) module continuously polls all 32 MDIO addresses in order to enumerate all PHY devices in the system. Once a PHY candidate has been selected by the DSP, the MDIO module transparently monitors its link state by reading the PHY status register. Link change events are stored in the MDIO module and can optionally interrupt the DSP, allowing the DSP to poll the link status of the device without continuously performing costly MDIO accesses. For more details on the MDIO, see the *TMS320C6000 DSP Ethernet Media Access Controller (EMAC) / Management Data Input/Output (MDIO) Module Reference Guide* (literature number SPRU628).

The I2C0 port on the TMS320DM643 allows the DSP to easily control peripheral devices and communicate with a host processor. In addition, the standard multichannel buffered serial port (McBSP) may be used to communicate with serial peripheral interface (SPI) mode peripheral devices.

The DM643 has a complete set of development tools which includes: a new C compiler, an assembly optimizer to simplify programming and scheduling, and a Windows® debugger interface for visibility into source code execution.

1.1 Device Compatibility

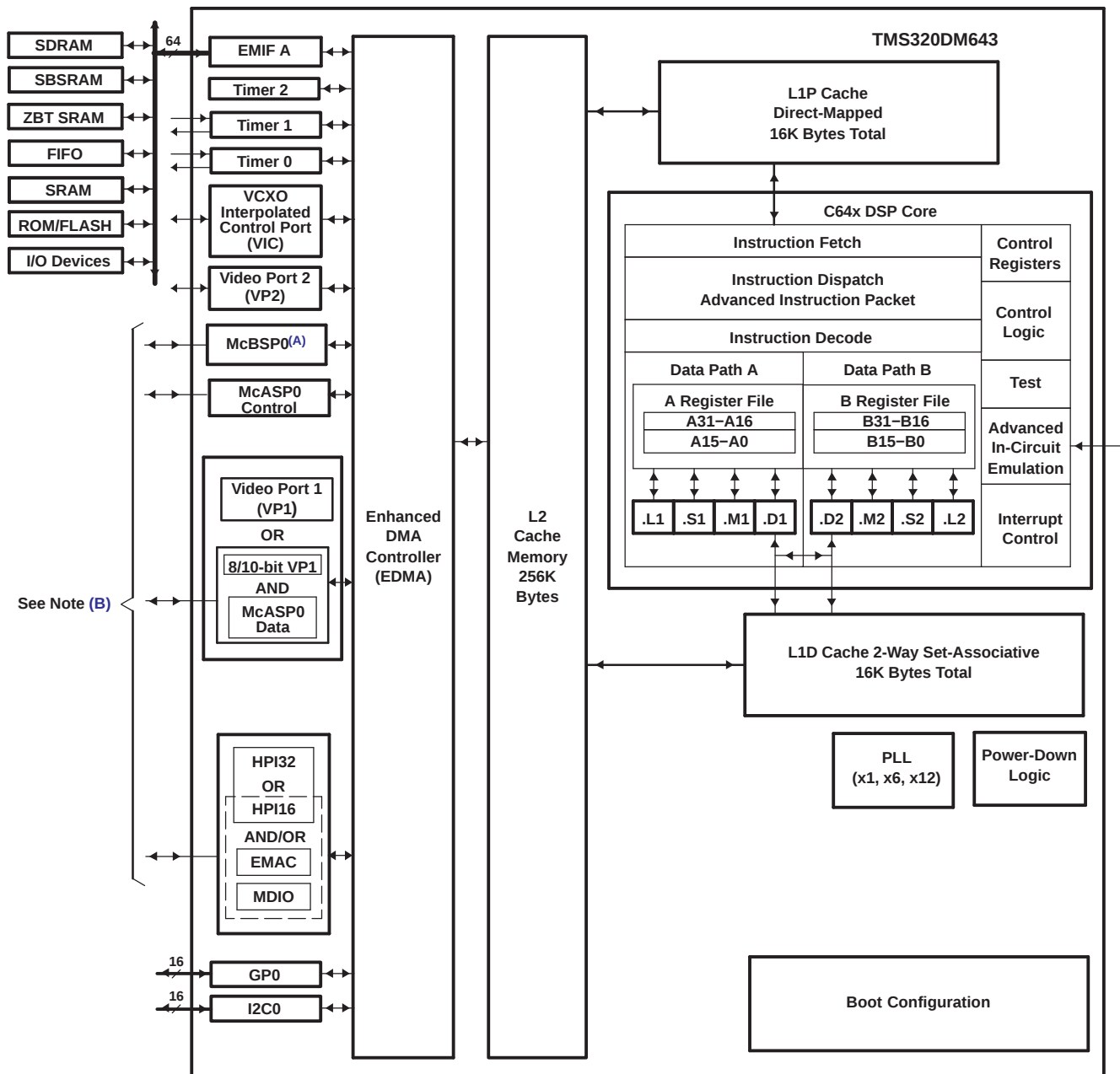
The DM643 device is a code-compatible member of the C6000™ DSP platform.

The C64x™ DSP generation of devices has a diverse and powerful set of peripherals.

For more detailed information on the device compatibility and similarities/differences among the DM642 and other C64x™ devices, see the *TMS320DM642 Technical Overview* (literature number SPRU615).

1.2 Functional Block Diagram

Figure 1-1 shows the functional block diagram of the DM643 device.



A. McBSP: AC97 Devices; SPI Devices; Codecs

B. The Video Port 1 (VP1) peripheral is muxed with the McASP0 data pins. The HPI(32/16) peripheral is muxed with the EMAC and MDIO peripherals. For more details on the multiplexed pins of these peripherals, see the Device Configurations section of this data sheet.

Figure 1-1. Functional Block Diagram

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2 Device Overview

2.1 Device Characteristics

Table 2-1 provides an overview of the DM643 DSP. The table shows significant features of the DM643 device, including the capacity of on-chip RAM, the peripherals, the CPU frequency, and the package type with pin count.

Table 2-1. Characteristics of the DM643 Processor

HARDWARE FEATURES		DM643
Peripherals Not all peripherals pins are available at the same time (For more detail, see the Device Configuration section).	EMIFA (64-bit bus width) (clock source = AECLKIN)	1
	EDMA (64 independent channels)	1
	McASP0 (uses Peripheral Clock [AUXCLK])	1
	I2C0 (uses Peripheral Clock)	1
	HPI (32- or 16-bit user selectable)	1 (HPI16 or HPI32)
	McBSP (internal clock source = CPU/4 clock frequency)	1
	Configurable Video Ports (VP1 and VP2)	2
	10/100 Ethernet MAC (EMAC)	1
	Management Data Input/Output (MDIO)	1
	VCXO Interpolated Control Port (VIC)	1
	32-Bit Timers (internal clock source = CPU/8 clock frequency)	3
	General-Purpose Input/Output Port (GP0)	16
On-Chip Memory	Size (Bytes)	288K
	Organization	16K-Byte (16KB) L1 Program (L1P) Cache 16KB L1 Data (L1D) Cache 256KB Unified Mapped RAM/Cache (L2)
CPU ID + CPU Rev ID	Control Status Register (CSR.[31:16])	0x0C01
JTAG BSDL_ID	JTAGID register (address location: 0x01B3F008)	0x0007902F
Frequency	MHz	500, 600
Cycle Time	ns	2 ns (DM643-500) [500 MHz CPU, 100 MHz EMIF ⁽¹⁾] 1.67 ns (DM643-600) [600 MHz CPU, 133 MHz EMIF ⁽¹⁾]
Voltage	Core (V)	1.2 V (-500) 1.4 V (-600)
	I/O (V)	3.3 V
PLL Options	CLKIN frequency multiplier	Bypass (x1), x6, x12
BGA Package	23 x 23 mm	548-Pin BGA (GDK and ZDK)
	27 x 27 mm	548-Pin BGA (GNZ and ZNZ)
Process Technology	μm	0.13 μm
Product Status ⁽²⁾	Product Preview (PP), Advance Information (AI), or Production Data (PD)	PD

(1) On this DM64x™ device, the rated EMIF speed affects only the SDRAM interface on the EMIF. For more detailed information, see the EMIF device speed portion of this data sheet.

(2) PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

2.2 CPU (DSP Core) Description

The CPU fetches VelociTI™ advanced very-long instruction words (VLIWs) (256 bits wide) to supply up to eight 32-bit instructions to the eight functional units during every clock cycle. The VelociTI™ VLIW architecture features controls by which all eight units do not have to be supplied with instructions if they are not ready to execute. The first bit of every 32-bit instruction determines if the next instruction belongs

to the same execute packet as the previous instruction, or whether it should be executed in the following clock as a part of the next execute packet. Fetch packets are always 256 bits wide; however, the execute packets can vary in size. The variable-length execute packets are a key memory-saving feature, distinguishing the C64x CPUs from other VLIW architectures. The C64x™ VelociTI.2™ extensions add enhancements to the TMS320C62x™ DSP VelociTI™ architecture. These enhancements include:

- Register file enhancements
- Data path extensions
- Quad 8-bit and dual 16-bit extensions with data flow enhancements
- Additional functional unit hardware
- Increased orthogonality of the instruction set
- Additional instructions that reduce code size and increase register flexibility

The CPU features two sets of functional units. Each set contains four units and a register file. One set contains functional units .L1, .S1, .M1, and .D1; the other set contains units .D2, .M2, .S2, and .L2. The two register files each contain 32 32-bit registers for a total of 64 general-purpose registers. In addition to supporting the packed 16-bit and 32-/40-bit fixed-point data types found in the C62x™ VelociTI™ VLIW architecture, the C64x™ register files also support packed 8-bit data and 64-bit fixed-point data types. The two sets of functional units, along with two register files, compose sides A and B of the CPU [see the functional block and CPU (DSP core) diagram, and [Figure 2-1](#)]. The four functional units on each side of the CPU can freely share the 32 registers belonging to that side. Additionally, each side features a "data cross path"—a single data bus connected to all the registers on the other side, by which the two sets of functional units can access data from the register files on the opposite side. The C64x CPU pipelines data-cross-path accesses over multiple clock cycles. This allows the same register to be used as a data-cross-path operand by multiple functional units in the same execute packet. All functional units in the C64x CPU can access operands via the data cross path. Register access by functional units on the same side of the CPU as the register file can service all the units in a single clock cycle. On the C64x CPU, a delay clock is introduced whenever an instruction attempts to read a register via a data cross path if that register was updated in the previous clock cycle.

In addition to the C62x™ DSP fixed-point instructions, the C64x™ DSP includes a comprehensive collection of quad 8-bit and dual 16-bit instruction set extensions. These VelociTI.2™ extensions allow the C64x CPU to operate directly on packed data to streamline data flow and increase instruction set efficiency. This is a key factor for video and imaging applications.

Another key feature of the C64x CPU is the load/store architecture, where all instructions operate on registers (as opposed to data in memory). Two sets of data-addressing units (.D1 and .D2) are responsible for all data transfers between the register files and the memory. The data address driven by the .D units allows data addresses generated from one register file to be used to load or store data to or from the other register file. The C64x .D units can load and store bytes (8 bits), half-words (16 bits), and words (32 bits) with a single instruction. And with the new data path extensions, the C64x .D unit can load and store doublewords (64 bits) with a single instruction. Furthermore, the non-aligned load and store instructions allow the .D units to access words and doublewords on any byte boundary. The C64x CPU supports a variety of indirect addressing modes using either linear- or circular-addressing with 5- or 15-bit offsets. All instructions are conditional, and most can access any one of the 64 registers. Some registers, however, are singled out to support specific addressing modes or to hold the condition for conditional instructions (if the condition is not automatically "true").

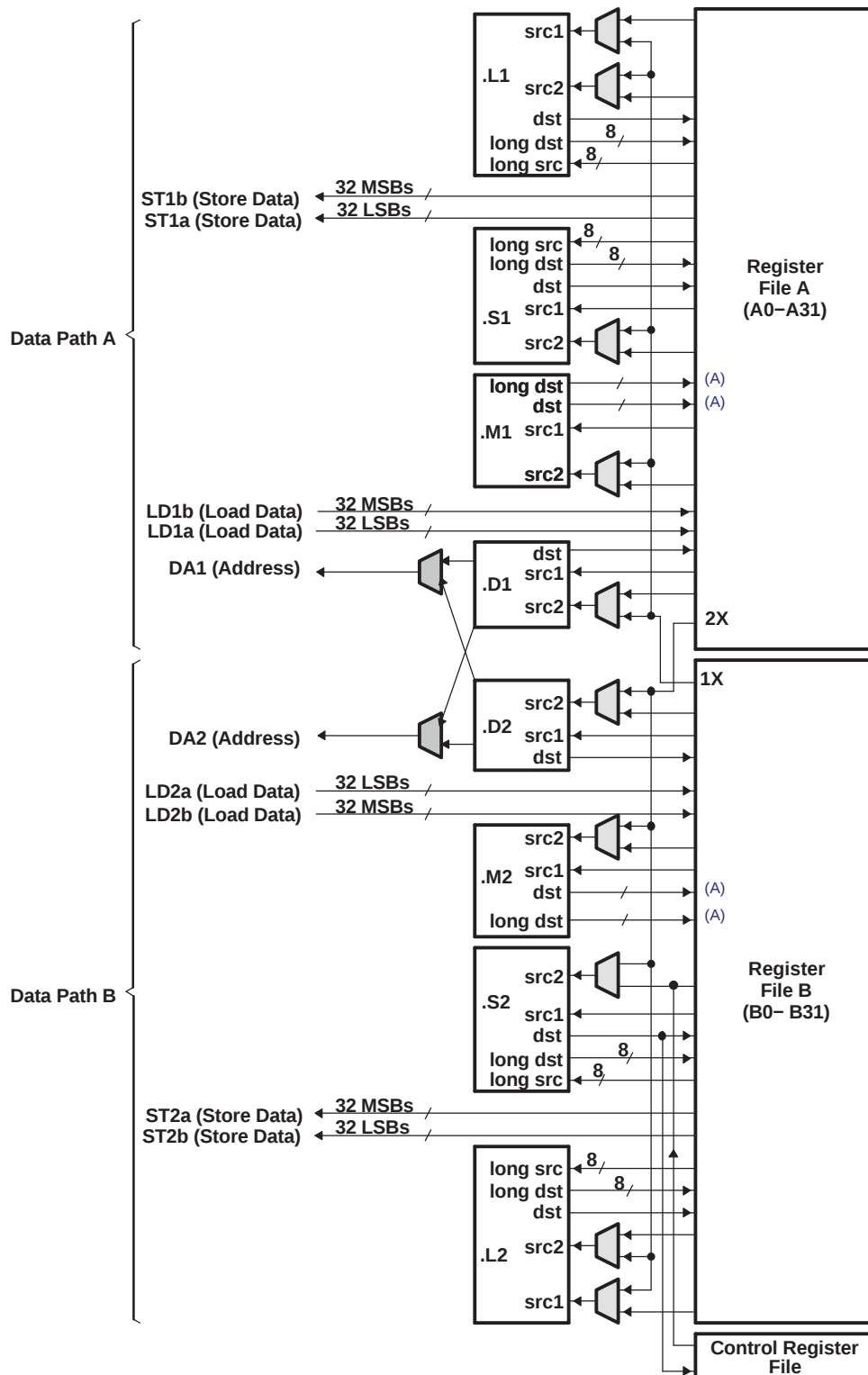
The two .M functional units perform all multiplication operations. Each of the C64x .M units can perform two 16 × 16-bit multiplies or four 8 × 8-bit multiplies per clock cycle. The .M unit can also perform 16 × 32-bit multiply operations, dual 16 × 16-bit multiplies with add/subtract operations, and quad 8 × 8-bit multiplies with add operations. In addition to standard multiplies, the C64x .M units include bit-count, rotate, Galois field multiplies, and bidirectional variable shift hardware.

The two .S and .L functional units perform a general set of arithmetic, logical, and branch functions with results available every clock cycle. The arithmetic and logical functions on the C64x CPU include single 32-bit, dual 16-bit, and quad 8-bit operations.

The processing flow begins when a 256-bit-wide instruction fetch packet is fetched from a program memory. The 32-bit instructions destined for the individual functional units are "linked" together by "1" bits in the least significant bit (LSB) position of the instructions. The instructions that are "chained" together for simultaneous execution (up to eight in total) compose an execute packet. A "0" in the LSB of an instruction breaks the chain, effectively placing the instructions that follow it in the next execute packet. A C64x™ DSP device enhancement now allows execute packets to cross fetch-packet boundaries. In the TMS320C62x™/TMS320C67x™ DSP devices, if an execute packet crosses the fetch-packet boundary (256 bits wide), the assembler places it in the next fetch packet, while the remainder of the current fetch packet is padded with NOP instructions. In the C64x™ DSP device, the execute boundary restrictions have been removed, thereby, eliminating all of the NOPs added to pad the fetch packet, and thus, decreasing the overall code size. The number of execute packets within a fetch packet can vary from one to eight. Execute packets are dispatched to their respective functional units at the rate of one per clock cycle and the next 256-bit fetch packet is not fetched until all the execute packets from the current fetch packet have been dispatched. After decoding, the instructions simultaneously drive all active functional units for a maximum execution rate of eight instructions every clock cycle. While most results are stored in 32-bit registers, they can be subsequently moved to memory as bytes, half-words, or doublewords. All load and store instructions are byte-, half-word-, word-, or doubleword-addressable.

For more details on the C64x CPU functional units enhancements, see the following documents:

- *TMS320C6000 CPU and Instruction Set Reference Guide* (literature number SPRU189)
- *TMS320C64x Technical Overview* (literature number SPRU395)



A. For the .M functional units, the long dst is 32 MSBs and the dst is 32 LSBs.

Figure 2-1. TMS320C64x™ CPU (DSP Core) Data Paths

2.2.1 CPU Core Registers

Table 2-2. L2 Cache Registers (C64x)

HEX ADDRESS RANGE	ACRONYM	REGISTER NAME	COMMENTS
0184 0000	CCFG	Cache configuration register	
0184 0004 – 0184 0FFC	–	Reserved	
0184 1000	EDMAWEIGHT	L2 EDMA access control register	
0184 1004 – 0184 1FFC	–	Reserved	
0184 2000	L2ALLOC0	L2 allocation register 0	
0184 2004	L2ALLOC1	L2 allocation register 1	
0184 2008	L2ALLOC2	L2 allocation register 2	
0184 200C	L2ALLOC3	L2 allocation register 3	
0184 2010 – 0184 3FFC	–	Reserved	
0184 4000	L2WBAR	L2 writeback base address register	
0184 4004	L2WWC	L2 writeback word count register	
0184 4010	L2WIBAR	L2 writeback invalidate base address register	
0184 4014	L2WIWC	L2 writeback invalidate word count register	
0184 4018	L2IBAR	L2 invalidate base address register	
0184 401C	L2IWC	L2 invalidate word count register	
0184 4020	L1PIBAR	L1P invalidate base address register	
0184 4024	L1PIWC	L1P invalidate word count register	
0184 4030	L1DWIBAR	L1D writeback invalidate base address register	
0184 4034	L1DWIWC	L1D writeback invalidate word count register	
0184 4038 – 0184 4044	–	Reserved	
0184 4048	L1DIBAR	L1D invalidate base address register	
0184 404C	L1DIWC	L1D invalidate word count register	
0184 4050 – 0184 4FFC	–	Reserved	
0184 5000	L2WB	L2 writeback all register	
0184 5004	L2WBINV	L2 writeback invalidate all register	
0184 5008 – 0184 7FFC	–	Reserved	
0184 8000 – 0184 81FC	MAR0 to MAR127	Reserved	
0184 8200	MAR128	Controls EMIFA CE0 range 8000 0000 – 80FF FFFF	
0184 8204	MAR129	Controls EMIFA CE0 range 8100 0000 – 81FF FFFF	
0184 8208	MAR130	Controls EMIFA CE0 range 8200 0000 – 82FF FFFF	
0184 820C	MAR131	Controls EMIFA CE0 range 8300 0000 – 83FF FFFF	
0184 8210	MAR132	Controls EMIFA CE0 range 8400 0000 – 84FF FFFF	
0184 8214	MAR133	Controls EMIFA CE0 range 8500 0000 – 85FF FFFF	
0184 8218	MAR134	Controls EMIFA CE0 range 8600 0000 – 86FF FFFF	
0184 821C	MAR135	Controls EMIFA CE0 range 8700 0000 – 87FF FFFF	
0184 8220	MAR136	Controls EMIFA CE0 range 8800 0000 – 88FF FFFF	
0184 8224	MAR137	Controls EMIFA CE0 range 8900 0000 – 89FF FFFF	
0184 8228	MAR138	Controls EMIFA CE0 range 8A00 0000 – 8AFF FFFF	
0184 822C	MAR139	Controls EMIFA CE0 range 8B	

Table 2-2. L2 Cache Registers (C64x) (continued)

HEX ADDRESS RANGE	ACRONYM	REGISTER NAME	COMMENTS
0184 8248	MAR146	Controls EMIFA CE1 range 9200 0000 – 92FF FFFF	
0184 824C	MAR147	Controls EMIFA CE1 range 9300 0000 – 93FF FFFF	
0184 8250	MAR148	Controls EMIFA CE1 range 9400 0000 – 94FF FFFF	
0184 8254	MAR149	Controls EMIFA CE1 range 9500 0000 – 95FF FFFF	
0184 8258	MAR150	Controls EMIFA CE1 range 9600 0000 – 96FF FFFF	
0184 825C	MAR151	Controls EMIFA CE1 range 9700 0000 – 97FF FFFF	
0184 8260	MAR152	Controls EMIFA CE1 range 9800 0000 – 98FF FFFF	
0184 8264	MAR153	Controls EMIFA CE1 range 9900 0000 – 99FF FFFF	
0184 8268	MAR154	Controls EMIFA CE1 range 9A00 0000 – 9AFF FFFF	
0184 826C	MAR155	Controls EMIFA CE1 range 9B00 0000 – 9BFF FFFF	
0184 8270	MAR156	Controls EMIFA CE1 range 9C00 0000 – 9CFF FFFF	
0184 8274	MAR157	Controls EMIFA CE1 range 9D00 0000 – 9DFF FFFF	
0184 8278	MAR158	Controls EMIFA CE1 range 9E00 0000 – 9EFF FFFF	
0184 827C	MAR159	Controls EMIFA CE1 range 9F00 0000 – 9FFF FFFF	
0184 8280	MAR160	Controls EMIFA CE2 range A000 0000 – A0FF FFFF	
0184 8284	MAR161	Controls EMIFA CE2 range A100 0000 – A1FF FFFF	
0184 8288	MAR162	Controls EMIFA CE2 range A200 0000 – A2FF FFFF	
0184 828C	MAR163	Controls EMIFA CE2 range A300 0000 – A3FF FFFF	
0184 8290	MAR164	Controls EMIFA CE2 range A400 0000 – A4FF FFFF	
0184 8294	MAR165	Controls EMIFA CE2 range A500 0000 – A5FF FFFF	
0184 8298	MAR166	Controls EMIFA CE2 range A600 0000 – A6FF FFFF	
0184 829C	MAR167	Controls EMIFA CE2 range A700 0000 – A7FF FFFF	
0184 82A0	MAR168	Controls EMIFA CE2 range A800 0000 – A8FF FFFF	
0184 82A4	MAR169	Controls EMIFA CE2 range A900 0000 – A9FF FFFF	
0184 82A8	MAR170	Controls EMIFA CE2 range AA00 0000 – AAFF FFFF	
0184 82AC	MAR171	Controls EMIFA CE2 range AB00 0000 – ABFF FFFF	
0184 82B0	MAR172	Controls EMIFA CE2 range AC00 0000 – ACFF FFFF	
0184 82B4	MAR173	Controls EMIFA CE2 range AD00 0000 – ADFF FFFF	
0184 82B8	MAR174	Controls EMIFA CE2 range AE00 0000 – AEFF FFFF	
0184 82BC	MAR175	Controls EMIFA CE2 range AF00 0000 – AFFF FFFF	
0184 82C0	MAR176	Controls EMIFA CE3 range B000 0000 – B0FF FFFF	
0184 82C4	MAR177	Controls EMIFA CE3 range B100 0000 – B1FF FFFF	
0184 82C8	MAR178	Controls EMIFA CE3 range B200 0000 – B2FF FFFF	
0184 82CC	MAR179	Controls EMIFA CE3 range B300 0000 – B3FF F	

Table 2-2. L2 Cache Registers (C64x) (continued)

HEX ADDRESS RANGE	ACRONYM	REGISTER NAME	COMMENTS
0184 8400 – 0187 FFFF	–	Reserved	

2.3 Memory Map Summary

Table 2-3 shows the memory map address ranges of the DM643 device. Internal memory is always located at address 0 and can be used as both program and data memory. The external memory address ranges in the DM643 device begin at the hex address location 0x8000 0000 for EMIFA.

Table 2-3. TMS320DM643 Memory Map Summary

MEMORY BLOCK DESCRIPTION	BLOCK SIZE (BYTES)	HEX ADDRESS RANGE
Internal RAM (L2)	256K	0000 0000 – 0003 FFFF
Reserved	768K	0004 0000 – 000F FFFF
Reserved	23M	0010 0000 – 017F FFFF
External Memory Interface A (EMIFA) Registers	256K	0180 0000 – 0183 FFFF
L2 Registers	256K	0184 0000 – 0187 FFFF
HPI Registers	256K	0188 0000 – 018B FFFF
McBSP 0 Registers	256K	018C 0000 – 018F FFFF
Reserved	256K	0190 0000 – 0193 FFFF
Timer 0 Registers	256K	0194 0000 – 0197 FFFF
Timer 1 Registers	256K	0198 0000 – 019B FFFF
Interrupt Selector Registers	256K	019C 0000 – 019F FFFF
EDMA RAM and EDMA Registers	256K	01A0 0000 – 01A3 FFFF
Reserved	512K	01A4 0000 – 01AB FFFF
Timer 2 Registers	256K	01AC 0000 – 01AF FFFF
GP0 Registers	256K – 4K	01B0 0000 – 01B3 EFFF
Device Configuration Registers	4K	01B3 F000 – 01B3 FFFF
I2C0 Data and Control Registers	16K	01B4 0000 – 01B4 3FFF
Reserved	32K	01B4 4000 – 01B4 BFFF
McASP0 Control Registers	16K	01B4 C000 – 01B4 FFFF
Reserved	192K	01B5 0000 – 01B7 FFFF
Reserved	256K	01B8 0000 – 01BB FFFF
Emulation	256K	01BC 0000 – 01BF FFFF
Reserved	256K	01C0 0000 – 01C3 FFFF
Reserved	16K	01C4 0000 – 01C4 3FFF
VP1 Control	16K	01C4 4000 – 01C4 7FFF
VP2 Control	16K	01C4 8000 – 01C4 BFFF
VIC Control	16K	01C4 C000 – 01C4 FFFF
Reserved	192K	01C5 0000 – 01C7 FFFF
EMAC Control	4K	01C8 0000 – 01C8 0FFF
EMAC Wrapper	8K	01C8 1000 – 01C8 2FFF
EWRAP Registers	2K	01C8 3000 – 01C8 37FF
MDIO Control Registers	2K	01C8 3800 – 01C8 3FFF
Reserved	3.5M	01C8 4000 – 01FF FFFF
QDMA Registers	52	0200 0000 – 0200 0033
Reserved	928M – 52	0200 0034 – 2FFF FFFF
McBSP 0 Data	64M	3000 0000 – 33FF FFFF
Reserved	64M	3400 0000 – 37FF FFFF
Reserved	64M	3800 0000 – 3BFF FFFF
McASP0 Data	1M	3C00 0000 – 3C0F FFFF
Reserved	64	

Table 2-3. TMS320DM643 Memory Map Summary (continued)

MEMORY BLOCK DESCRIPTION	BLOCK SIZE (BYTES)	HEX ADDRESS RANGE
Reserved	32M	7600 0000 – 77FF FFFF
VP1 Channel A Data	32M	7800 0000 – 79FF FFFF
VP1 Channel B Data	32M	7A00 0000 – 7BFF FFFF
VP2 Channel A Data	32M	7C00 0000 – 7DFF FFFF
VP2 Channel B Data	32M	7E00 0000 – 7FFF FFFF
EMIFA CE0	256M	8000 0000 – 8FFF FFFF
EMIFA CE1	256M	9000 0000 – 9FFF FFFF
EMIFA CE2	256M	A000 0000 – AFFF FFFF
EMIFA CE3	256M	B000 0000 – BFFF FFFF
Reserved	1G	C000 0000 – FFFF FFFF

2.3.1 L2 Architecture Expanded

Figure 2-2 shows the detail of the L2 architecture on the TMS320DM643 device. For more information on the L2MODE bits, see the cache configuration (CCFG) register bit field descriptions in the *TMS320C64x Two-Level Internal Memory Reference Guide* (literature number SPRU610).

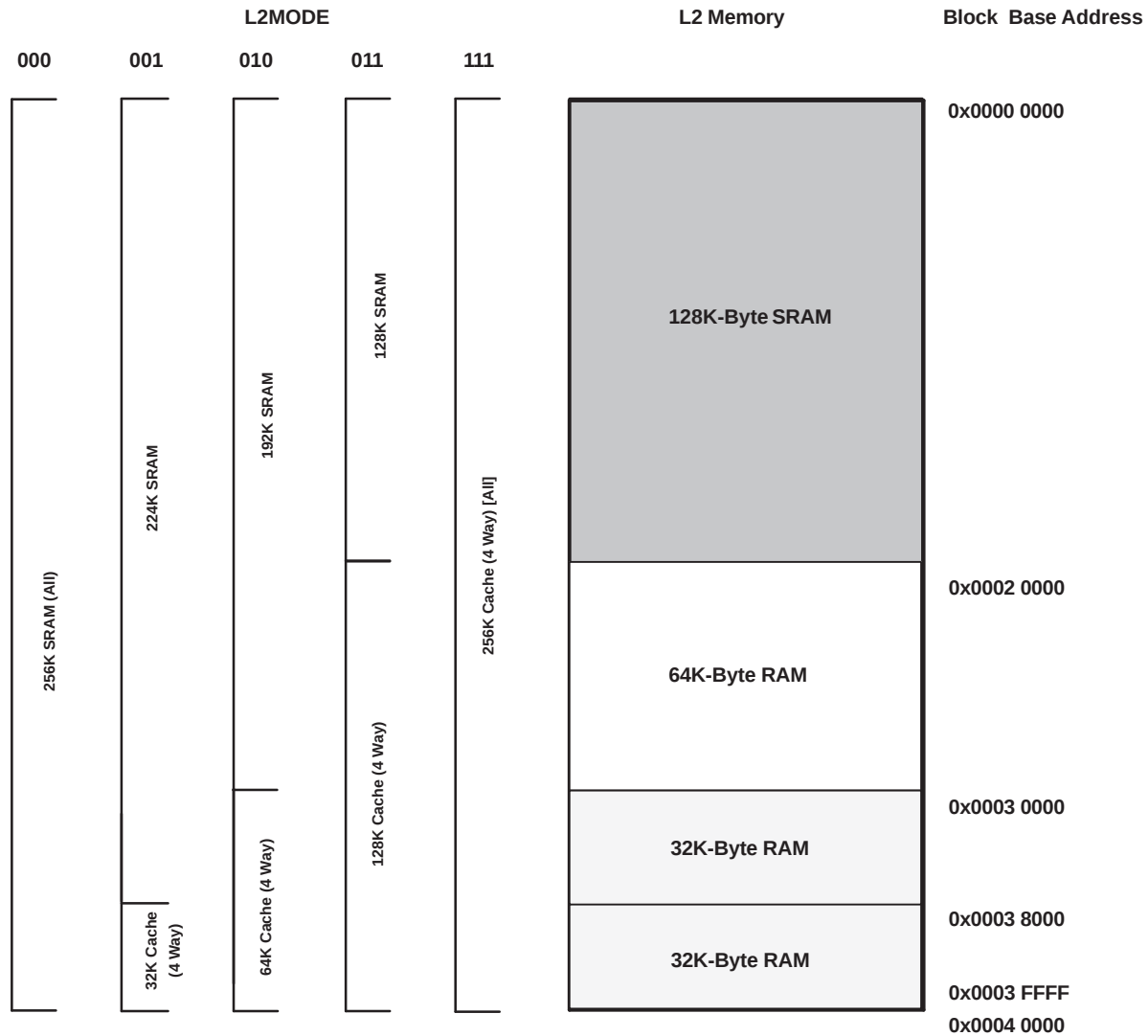


Figure 2-2. TMS320DM643 L2 Architecture Memory Configuration

2.4 Bootmode

The DM643 device resets using the active-low signal $\overline{\text{RESET}}$. While $\overline{\text{RESET}}$ is low, the device is held in reset and is initialized to the prescribed reset state. Refer to reset timing for reset timing characteristics and states of device pins during reset. The release of $\overline{\text{RESET}}$ starts the processor running with the prescribed device configuration and boot mode.

The DM643 has three types of boot modes:

- Host boot

If host boot is selected, upon release of $\overline{\text{RESET}}$, the CPU is internally "stalled" while the remainder of the device is released. During this period, an external host can initialize the CPU's memory space as necessary through the host interface, including internal configuration registers, such as those that control the EMIF or other peripherals. Once the host is finished with all necessary initialization, it must set the DSPINT bit in the HPIC register to complete the boot process. This transition causes the boot configuration logic to bring the CPU out of the "stalled" state. The CPU then begins execution from address 0. The DSPINT condition is not latched by the CPU, because it occurs while the CPU is still internally "stalled". Also, DSPINT brings the CPU out of the "stalled" state only if the host boot process is selected. All memory may be written to and read by the host. This allows for the host to verify what it sends to the DSP if required. After the CPU is out of the "stalled" state, the CPU needs to clear the DSPINT, otherwise, no more DSPINTs can be received.

- EMIF boot (using default ROM timings)

Upon the release of $\overline{\text{RESET}}$, the 1K-Byte ROM code located in the beginning of CE1 is copied to address 0 by the EDMA using the default ROM timings, while the CPU is internally "stalled". The data should be stored in the endian format that the system is using. In this case, the EMIF automatically assembles consecutive 8-bit bytes to form the 32-bit instruction words to be copied. The transfer is automatically done by the EDMA as a single-frame block transfer from the ROM to address 0. After completion of the block transfer, the CPU is released from the "stalled" state and starts running from address 0.

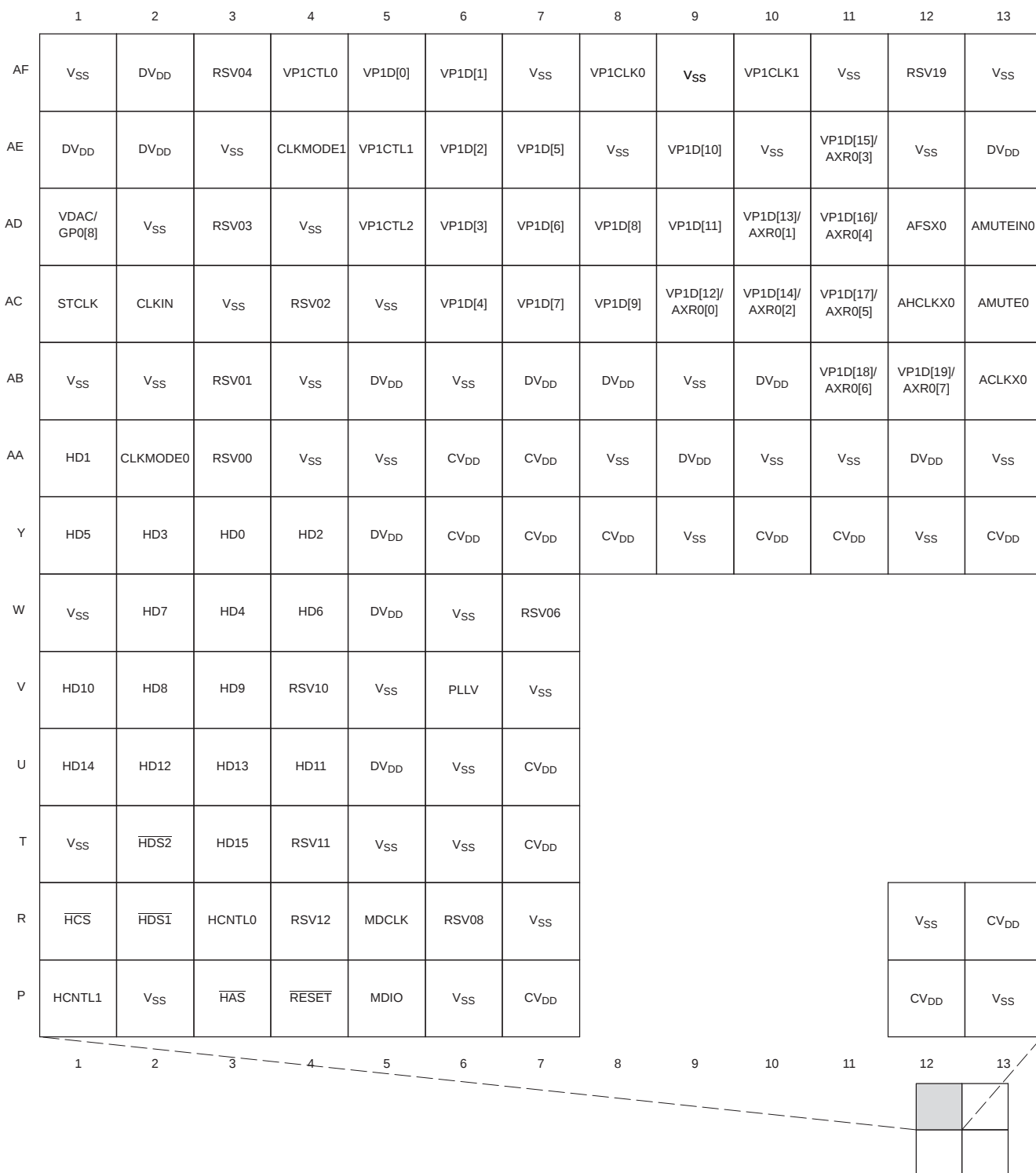
- No boot

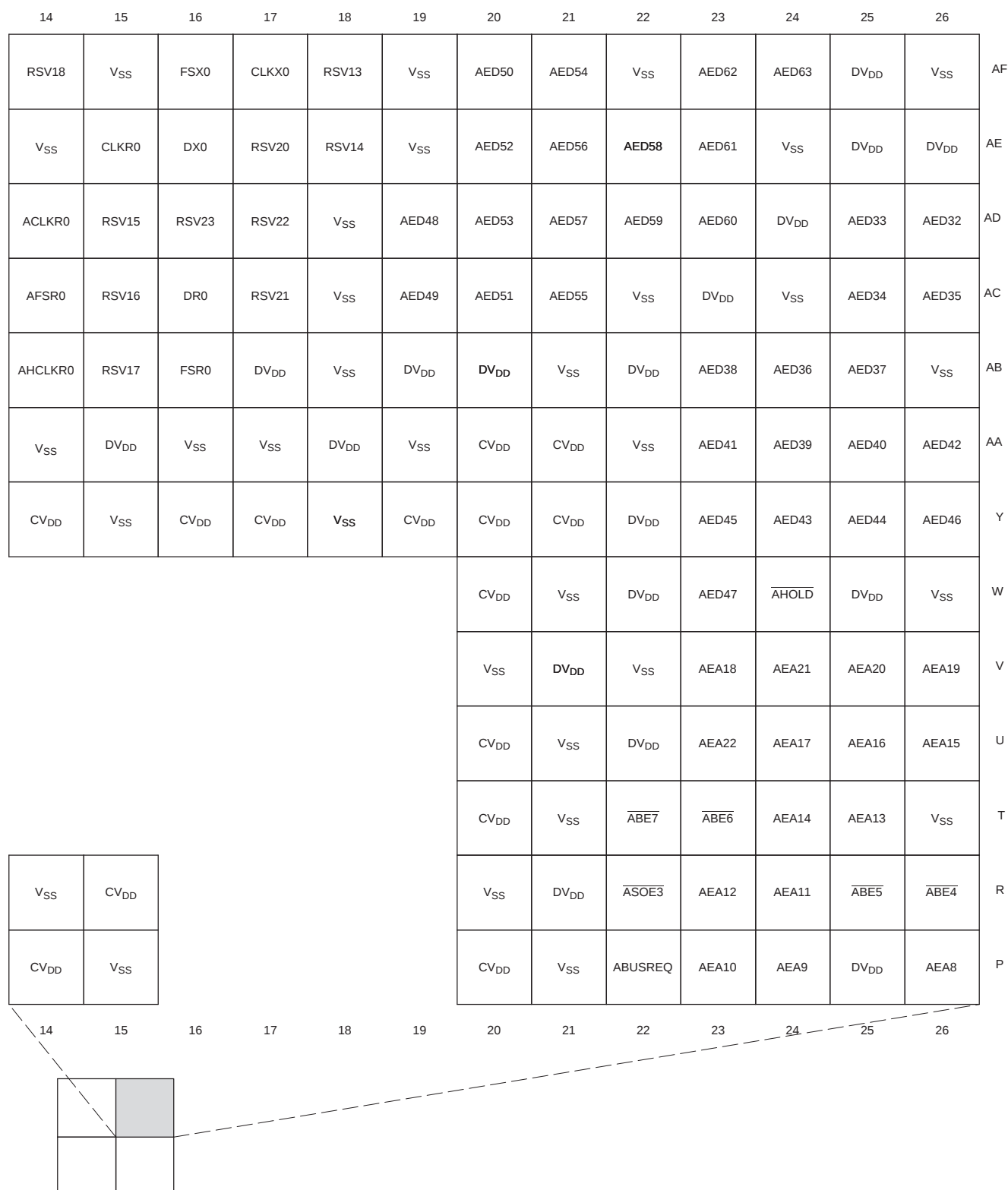
With no boot, the CPU begins direct execution from the memory located at address 0. Note: operation is undefined if invalid code is located at address 0.

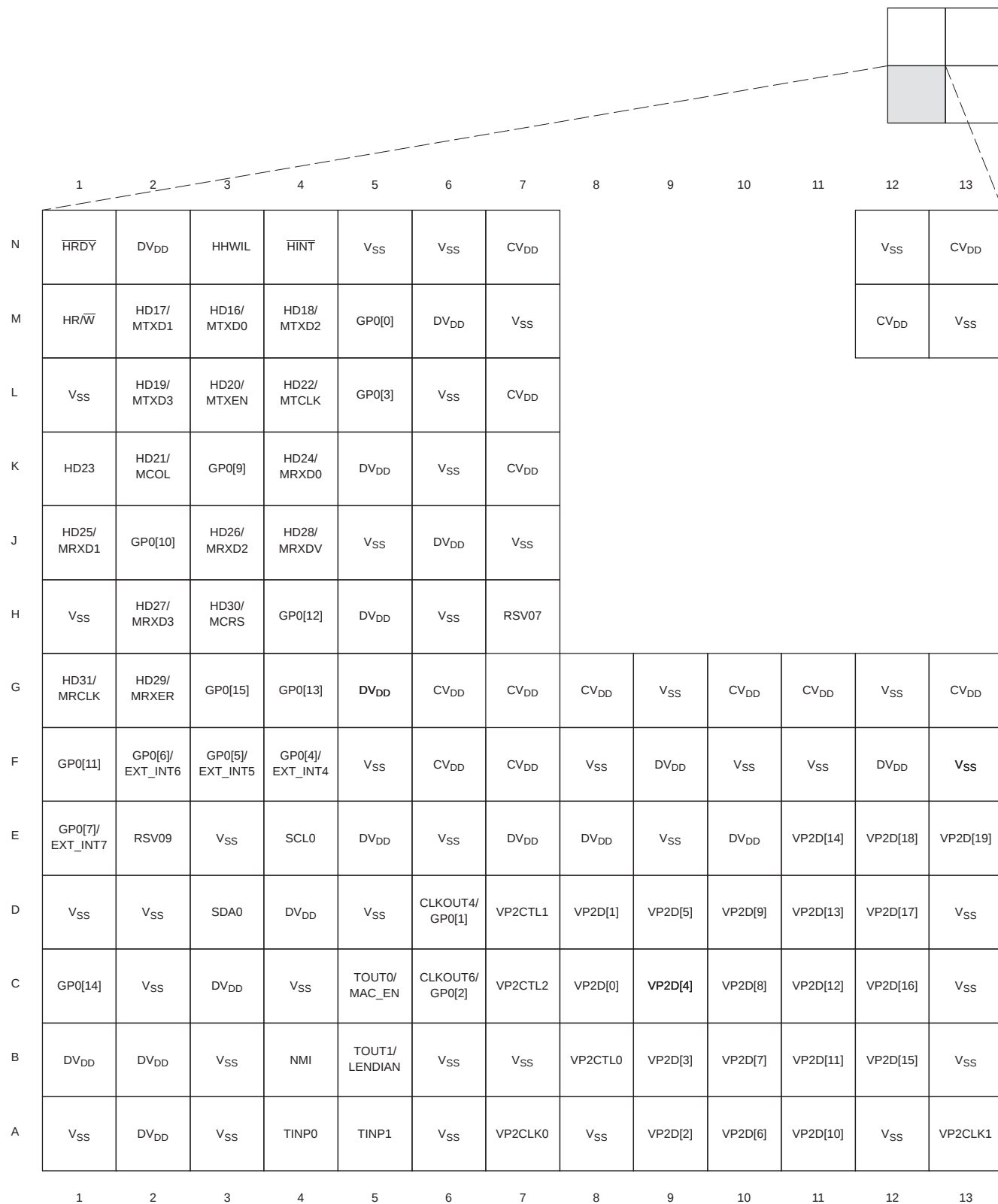
2.5 Pin Assignments

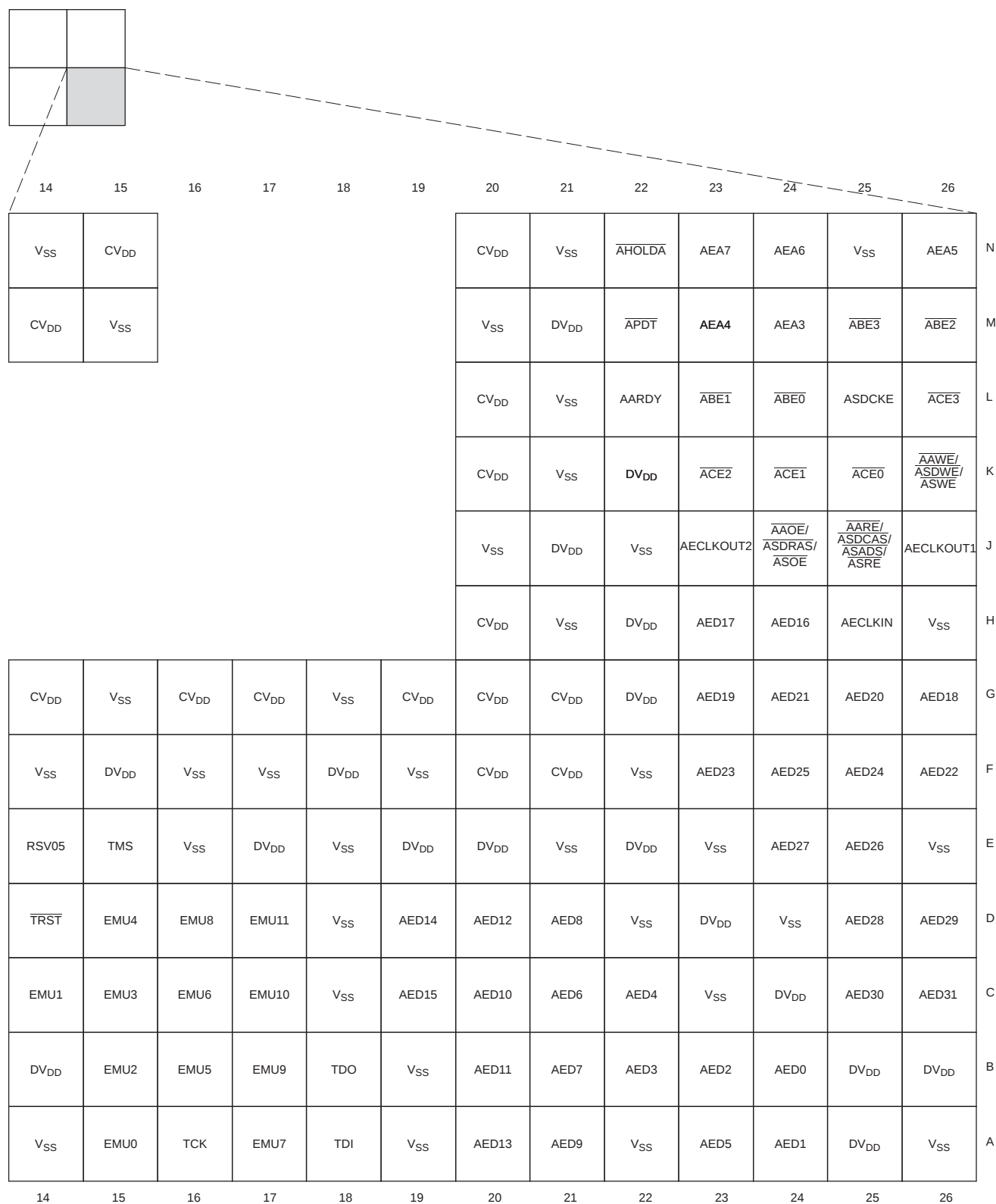
2.5.1 Pin Map

Figure 2-3 through Figure 2-6 show the DM643 pin assignments in four quadrants (A, B, C, and D).

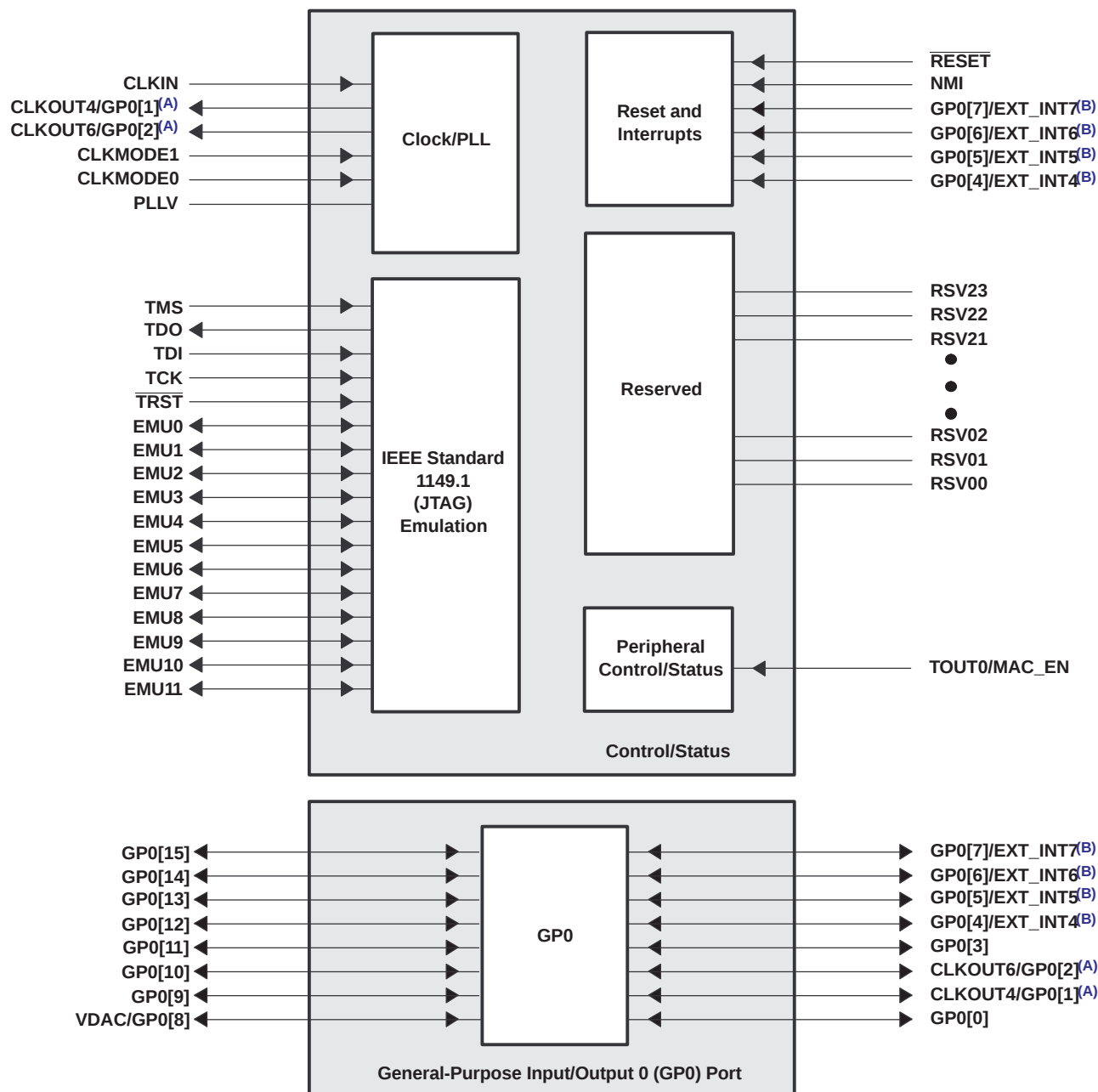





Figure 2-5. DM643 Pin Map [Quadrant C]



2.5.2 Signal Groups Description



- A. These pins are muxed with the GP0 pins and by default these signals function as clocks (CLKOUT4 or CLKOUT6). To use these muxed pins as GPIO signals, the appropriate GPIO register bits (GPxEN and GPxDIR) must be properly enabled and configured. For more details, see the Device Configurations section of this data sheet.
- B. These pins are GP0 pins that can also function as external interrupt sources (EXT_INT[7:4]). Default after reset is EXT_INTx or GPIO as input-only.

Figure 2-7. CPU and Peripheral Signals

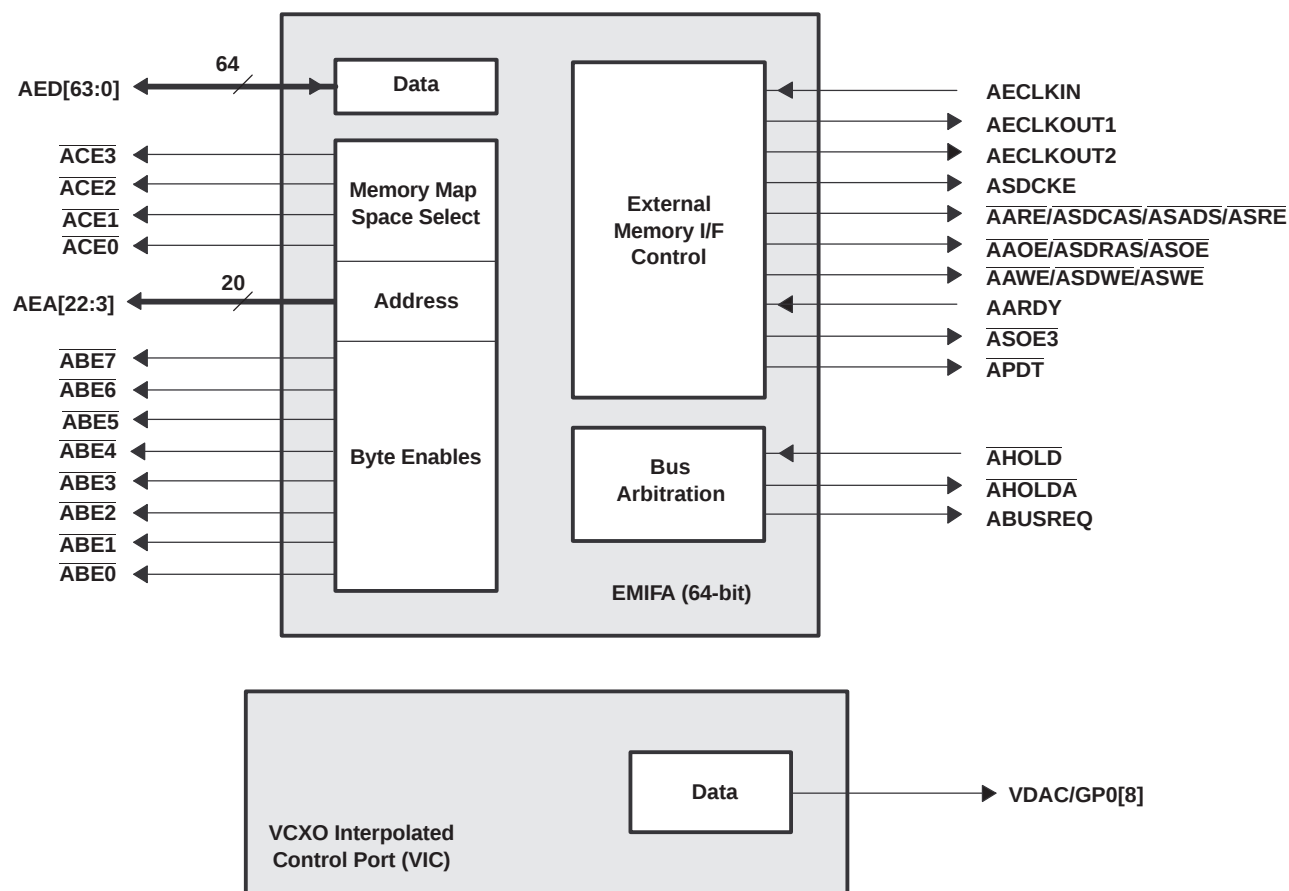
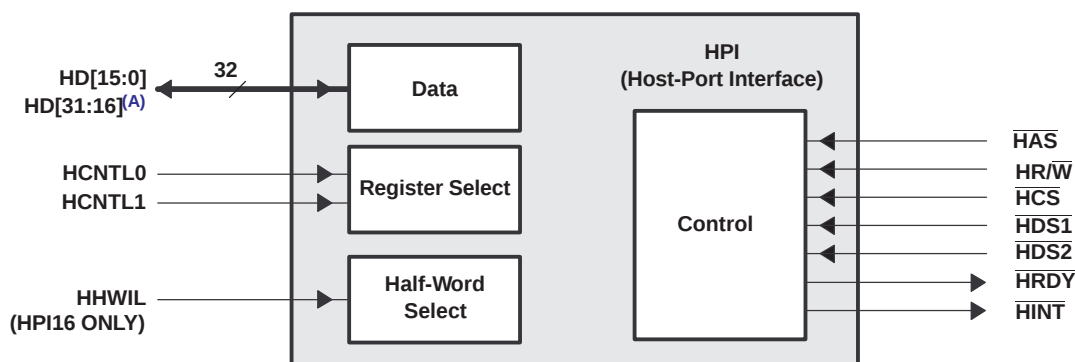


Figure 2-8. EMIFA/VIC Peripheral Signals



A. These HPI data pins (HD[31:16], excluding HD[23]) are muxed with the EMAC peripheral. By default, these pins function as HPI. For more details on the EMAC pin functions, see the Ethernet MAC (EMAC) peripheral signals section and the terminal functions table portions of this data sheet.

Figure 2-9. HPI Peripheral Signals

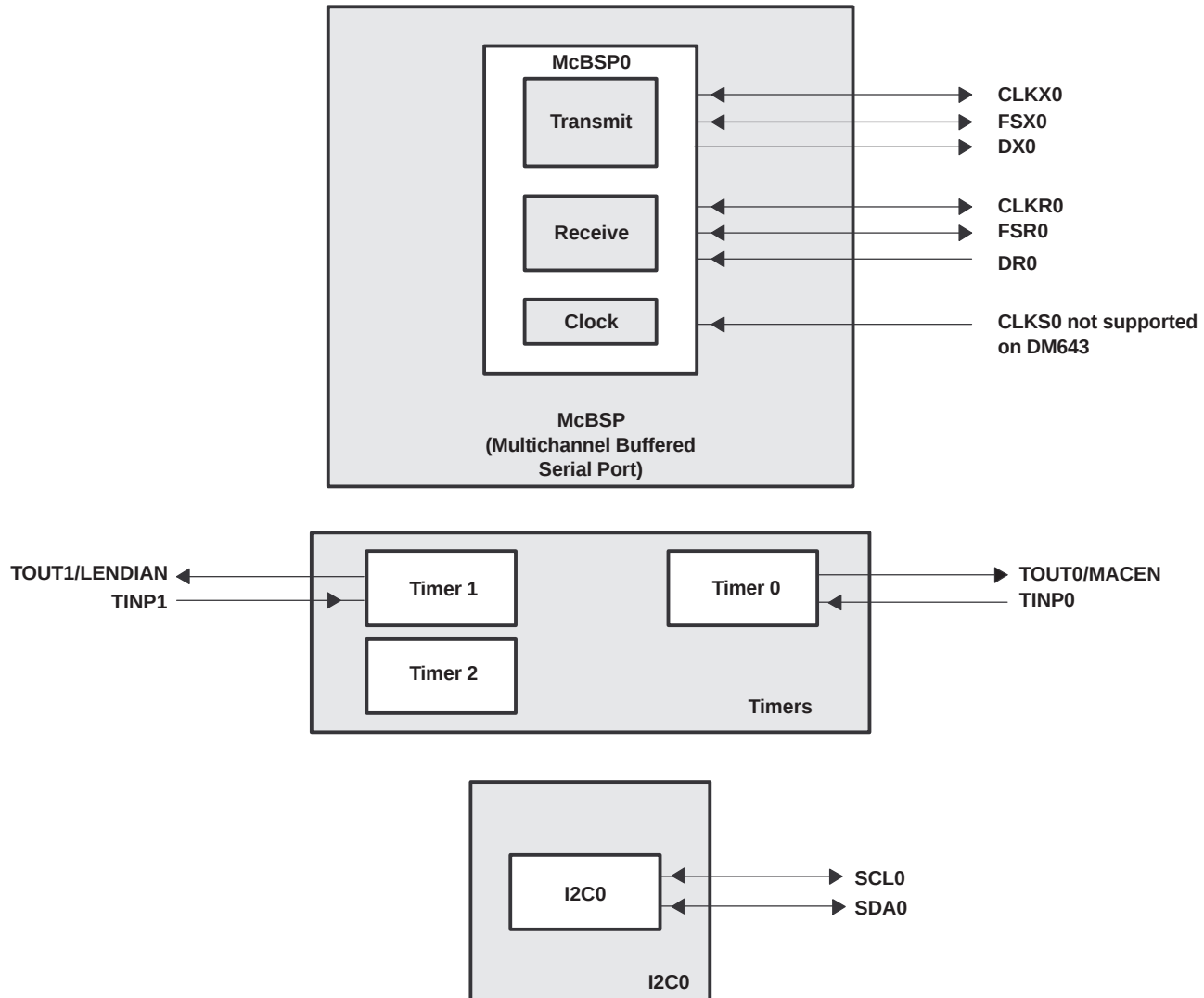
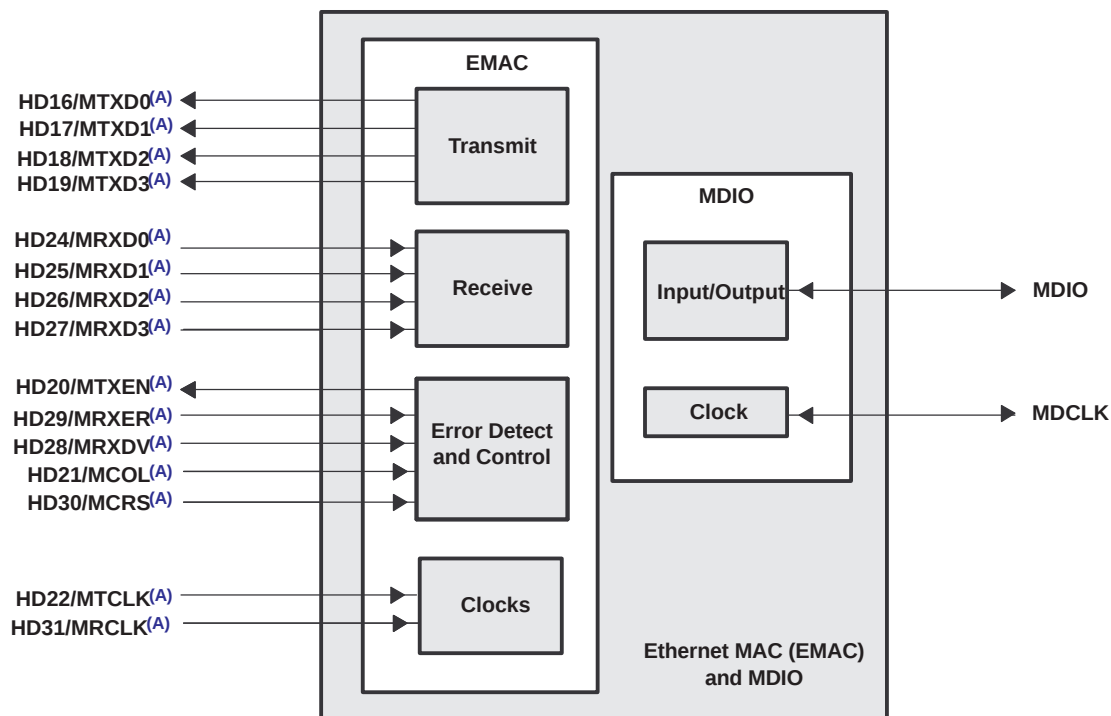
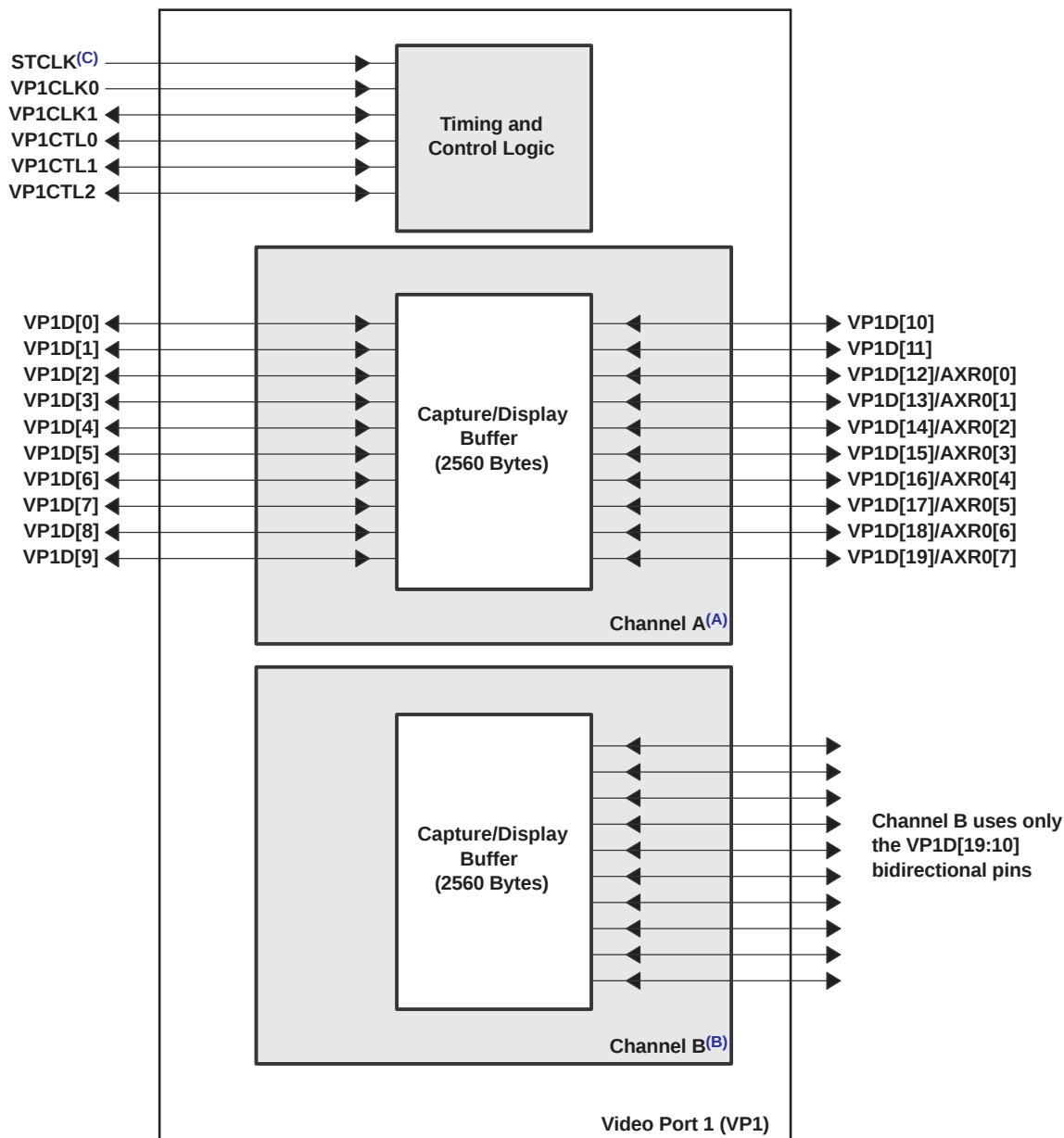


Figure 2-10. McBSP/Timer/I2C0 Peripheral Signals



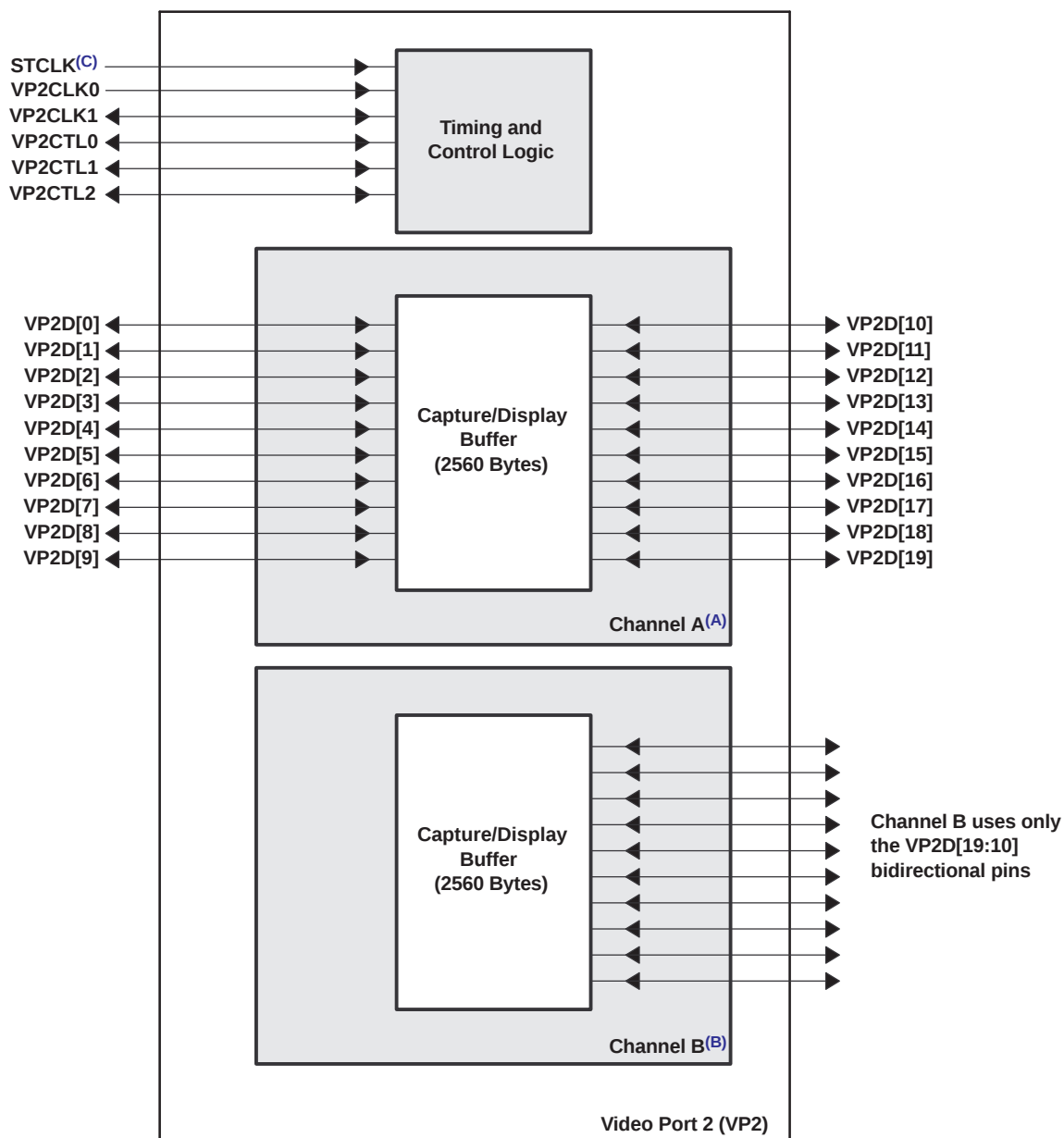
- A. These EMAC pins are muxed with the upper data pins of the HPI peripheral. By default, these signals function as HPI. For more details on these muxed pins, see the Device Configurations section of this data sheet.

Figure 2-11. EMAC/MDIO Peripheral Signals



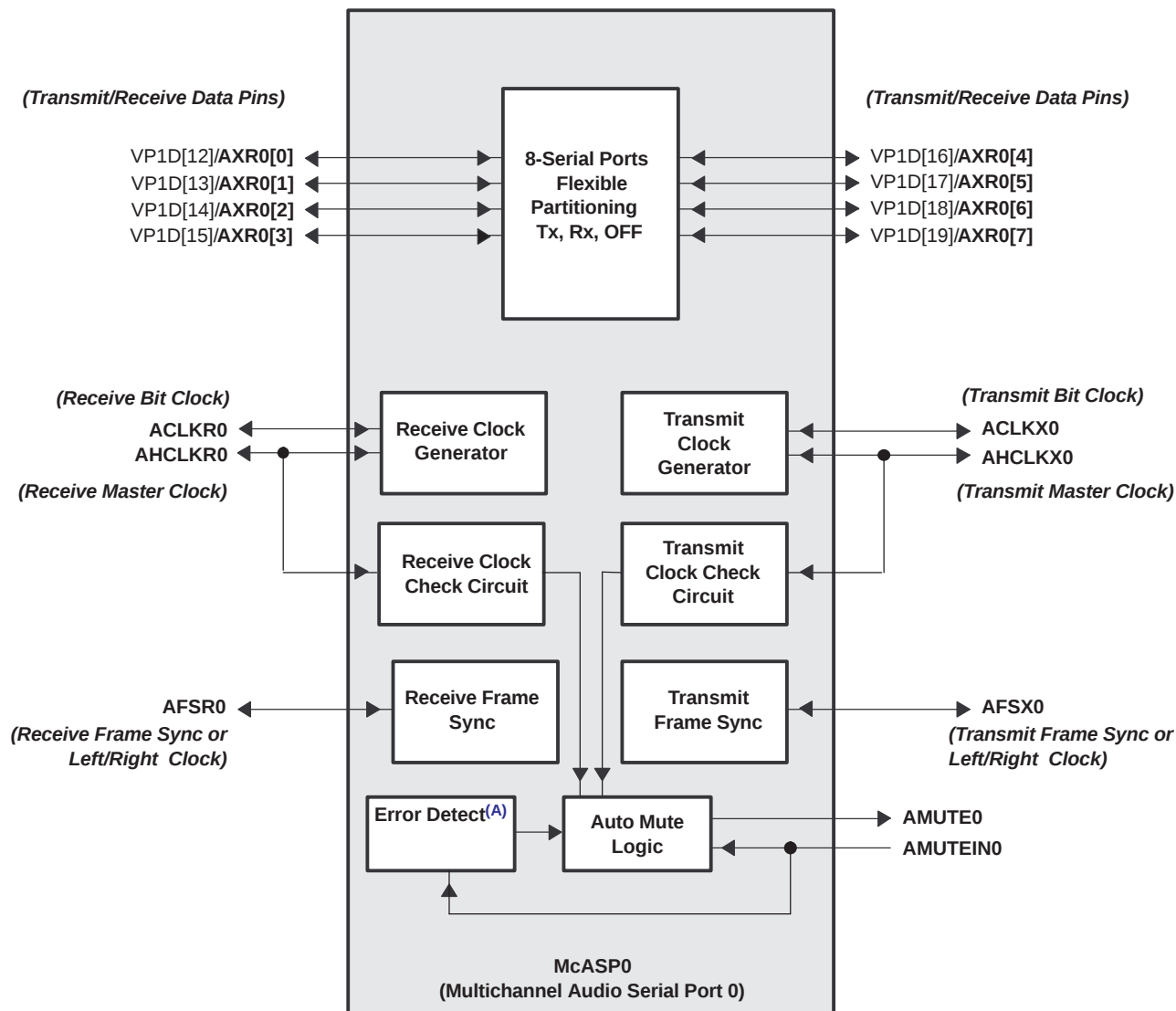
- A. Channel A supports: BT.656 (8/10-bit), Y/C Video (16/20-bit), RAW Video (16/20-bit) display modes and BT.656 (8/10-bit), Y/C Video (16/20-bit), RAW Video (16/20-bit) capture modes [TSI (8-bit) capture mode].
- B. Channel B supports: BT.656 (8/10-bit), RAW Video (8/10-bit) capture modes and can display synchronized RAW Video data with Channel A.
- C. The same STCLK signal is used for both video ports (VP1 and VP2).

Figure 2-12. Video Port 1 Peripheral Signals



- A. Channel A supports: BT.656 (8/10-bit), Y/C Video (16/20-bit), RAW Video (16/20-bit) display modes and BT.656 (8/10-bit), Y/C Video (16/20-bit), RAW Video (16/20-bit) capture modes [TSI (8-bit) capture mode].
- B. Channel B supports: BT.656 (8/10-bit), RAW Video (8/10-bit) capture modes and can display synchronized RAW Video data with Channel A.
- C. The same STCLK signal is used for both video ports (VP1 and VP2).

Figure 2-13. Video Port 2 Peripheral Signals



NOTES: On multiplexed pins, bolded text denotes the active function of the pin for that particular peripheral module.
Bolded and italicized text within parentheses denotes the function of the pins in an audio system.

A. The McASP's Error Detect function detects underruns, overruns, early/late frame syncs, DMA errors, and external mute input.

Figure 2-14. McASP0 Peripheral Signals

2.5.3 Terminal Functions

Table 2-4, the terminal functions table, identifies the external signal names, the associated pin (ball) numbers along with the mechanical package designator, the pin type (I, O/Z, or I/O/Z), whether the pin has any internal pullup/pulldown resistors and a functional pin description. For more detailed information on device configuration, peripheral selection, multiplexed/shared pins, and debugging considerations, see the Device Configurations section of this data sheet.

Table 2-4. Terminal Functions

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
CLOCK/PLL CONFIGURATION				
CLKIN	AC2	I		Clock Input. This clock is the input to the on-chip PLL.
CLKOUT4/GP0[1] ⁽³⁾	D6	I/O/Z	IPU	Clock output at 1/4 of the device speed (O/Z) [default] or this pin can be programmed as a GP0 1 pin (I/O/Z).
CLKOUT6/GP0[2] ⁽³⁾	C6	I/O/Z	IPU	Clock output at 1/6 of the device speed (O/Z) [default] or this pin can be programmed as a GP0 2 pin (I/O/Z).
CLKMODE1	AE4	I	IPD	Clock mode select
CLKMODE0	AA2	I	IPD	Selects whether the CPU clock frequency = input clock frequency x1 (Bypass), x6, or x12. For more details on the CLKMODE pins and the PLL multiply factors, see the Clock PLL section of this data sheet.
PLL ⁽⁴⁾	V6	A ⁽¹⁾		PLL voltage supply
JTAG EMULATION				
TMS	E15	I	IPU	JTAG test-port mode select
TDO	B18	O/Z	IPU	JTAG test-port data out
TDI	A18	I	IPU	JTAG test-port data in
TCK	A16	I	IPU	JTAG test-port clock
$\overline{\text{TRST}}$	D14	I	IPD	JTAG test-port reset. For IEEE 1149.1 JTAG compatibility, see the IEEE 1149.1 JTAG compatibility statement portion of this data sheet.
EMU11	D17	I/O/Z	IPU	Emulation pin 11. Reserved for future use, leave unconnected.
EMU10	C17	I/O/Z	IPU	Emulation pin 10. Reserved for future use, leave unconnected.
EMU9	B17	I/O/Z	IPU	Emulation pin 9. Reserved for future use, leave unconnected.
EMU8	D16	I/O/Z	IPU	Emulation pin 8. Reserved for future use, leave unconnected.
EMU7	A17	I/O/Z	IPU	Emulation pin 7. Reserved for future use, leave unconnected.
EMU6	C16	I/O/Z	IPU	Emulation pin 6. Reserved for future use, leave unconnected.
EMU5	B16	I/O/Z	IPU	Emulation pin 5. Reserved for future use, leave unconnected.
EMU4	D15	I/O/Z	IPU	Emulation pin 4. Reserved for future use, leave unconnected.
EMU3	C15	I/O/Z	IPU	Emulation pin 3. Reserved for future use, leave unconnected.
EMU2	B15	I/O/Z	IPU	Emulation pin 2. Reserved for future use, leave unconnected.
EMU1	C14	I/O/Z	IPU	Emulation pin 1 ⁽⁵⁾
EMU0	A15	I/O/Z	IPU	Emulation pin 0 ⁽⁵⁾
RESETS, INTERRUPTS, AND GENERAL-PURPOSE INPUT/OUTPUTS				
$\overline{\text{RESET}}$	P4	I		Device reset
NMI	B4	I	IPD	Nonmaskable interrupt, edge-driven (rising edge) Note: Any noise on the NMI pin may trigger an NMI interrupt; therefore, if the NMI pin is not used, it is recommended that the NMI pin be grounded versus relying on the IPD.

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
GP0[15]	G3	I/O/Z		General-purpose input/output GP0[15:9] pins (I/O/Z). Note: By default, no function is enabled upon reset. To configure these pins, see the Device Configuration section of this data sheet.
GP0[14]	C1			
GP0[13]	G4			
GP0[12]	H4			
GP0[11]	F1			
GP0[10]	J2			
GP0[9]	K3			
GP0[3]	L5		IPD	GP0 3 pin (I/O/Z)
GP0[0]	M5	I/O/Z	IPD	General-purpose 0 pin (GP0[0]) (I/O/Z) [default] This pin can be programmed as GPIO 0 (input only) [default] or as GP0[0] (output only) pin or output as a general-purpose interrupt (GP0INT) signal (output only). Note: This pin must remain low during device reset.
VDAC/GP0[8] ⁽³⁾	AD1	I/O/Z	IPD	VCXO Interpolated Control Port (VIC) single-bit digital-to-analog converter (VDAC) output [output only] [default] or this pin can be programmed as a GP0 8 pin (I/O/Z).
CLKOUT6/GP0[2] ⁽³⁾	C6	I/O/Z	IPD	Clock output at 1/6 of the device speed (O/Z) [default] or this pin can be programmed as a GP0 2 pin (I/O/Z).
CLKOUT4/GP0[1] ⁽³⁾	D6	I/O/Z	IPD	Clock output at 1/4 of the device speed (O/Z) [default] or this pin can be programmed as a GP0 1 pin (I/O/Z).
HOST-PORT INTERFACE (HPI) or EMAC				
HINT	N4	O/Z		Host interrupt from DSP to host (O).
HCNTL1	P1	I		Host control – selects between control, address, or data registers (I).
HCNTL0	R3	I		Host control – selects between control, address, or data registers (I).
HHWIL	N3	I		Host half-word select – first or second half-word (not necessarily high or low order). [For HPI16 bus width selection only] (I).
HR/W	M1	I		Host read or write select (I).
HAS	P3	I		Host address strobe (I)
HCS	R1	I		Host chip select (I)
HDS1	R2	I		Host data strobe 1 (I)
HDS2	T2	I		Host data strobe 2 (I)
HRDY	N1	O/Z		Note: If unused, the following HPI control signals should be externally pulled high. Host ready from DSP to host (O)

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
HD31/MRCLK ⁽⁶⁾	G1	I/O/Z		Host-port data (I/O/Z) [default] or EMAC transmit/receive or control pins As HPI data bus - Used for transfer of data, address, and control - Host-Port bus width user-configurable at device reset via a 10-kΩ resistor pullup/pulldown resistor on the HD5 pin: Note: If a configuration pin must be routed out from the device, the internal pullup/pulldown (IPU/IPD) resistor should not be relied upon; TI recommends the use of an external pullup/pulldown resistor. Boot Configuration: - HD5 pin = 0: HPI operates as an HPI16. (HPI bus is 16 bits wide. HD[15:0] pins are used and the remaining HD[31:16] pins are reserved pins in the high-impedance state.) - HD5 pin = 1: HPI operates as an HPI32. (HPI bus is 32 bits wide. All HD[31:0] pins are used for host-port operations.) For superset devices like DM643, the HD31 through HD16 pins can also function as EMAC transmit/receive or control pins (when MAC_EN pin = 1). For more details on the EMAC pin functions, see the <i>Ethernet MAC (EMAC) peripheral</i> section of this table and for more details on how to configure the EMAC pin functions, see the device configuration section of this data sheet.
HD30/MCRS ⁽⁶⁾	H3			
HD29/MRXER ⁽⁶⁾	G2			
HD28/MRXDV ⁽⁶⁾	J4			
HD27/MRXD3 ⁽⁶⁾	H2			
HD26/MRXD2 ⁽⁶⁾	J3			
HD25/MRXD1 ⁽⁶⁾	J1			
HD24/MRXD0 ⁽⁶⁾	K4			
HD23	K1			
HD22/MTCLK ⁽⁶⁾	L4			
HD21/MCOL ⁽⁶⁾	K2			
HD20/MTXEN ⁽⁶⁾	L3			
HD19/MTXD3 ⁽⁶⁾	L2			
HD18/MTXD2 ⁽⁶⁾	M4			
HD17/MTXD1 ⁽⁶⁾	M2			
HD16/MTXD0 ⁽⁶⁾	M3			
HD15	T3			
HD14	U1			
HD13	U3			
HD12	U2			
HD11	U4			
HD10	V1			
HD9	V3			
HD8	V2			
HD7	W2			
HD6	W4			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
$\overline{\text{APDT}}$	M22	O/Z	IPU	EMIFA peripheral data transfer, allows direct transfer between external peripherals
EMIFA (64-bit) – BUS ARBITRATION				
$\overline{\text{AHOLDA}}$	N22	O	IPU	EMIFA hold-request-acknowledge to the host
$\overline{\text{AHOLD}}$	W24	I	IPU	EMIFA hold request from the host
ABUSREQ	P22	O	IPU	EMIFA bus request output
EMIFA (64-bit) – ASYNCHRONOUS/SYNCHRONOUS MEMORY CONTROL				
AECLKIN	H25	I	IPD	EMIFA external input clock. The EMIFA input clock (AECLKIN, CPU/4 clock, or CPU/6 clock) is selected at reset via the pullup/pulldown resistors on the AEA[20:19] pins. AECLKIN is the default for the EMIFA input clock.
AECLKOUT2	J23	O/Z	IPD	EMIFA output clock 2. Programmable to be EMIFA input clock (AECLKIN, CPU/4 clock, or CPU/6 clock) frequency divided-by-1, -2, or -4.
AECLKOUT1	J26	O/Z	IPD	EMIFA output clock 1 [at EMIFA input clock (AECLKIN, CPU/4 clock, or CPU/6 clock) frequency].
$\overline{\text{AARE}}/$ $\overline{\text{ASDCAS}}/$ $\overline{\text{ASADS}}/\overline{\text{ASRE}}$	J25	O/Z	IPU	EMIFA asynchronous memory read-enable/SDRAM column-address strobe/programmable synchronous interface-address strobe or read-enable For programmable synchronous interface, the RENEN field in the CE Space Secondary Control Register (CEXSEC) selects between ASADS and ASRE: If RENEN = 0, then the ASADS/ASRE signal functions as the ASADS signal. If RENEN = 1, then the ASADS/ASRE signal functions as the ASRE signal.
$\overline{\text{AAOE}}/$ $\overline{\text{ASDRAS}}/$ $\overline{\text{ASOE}}$	J24	O/Z	IPU	EMIFA asynchronous memory output-enable/SDRAM row-address strobe/programmable synchronous interface output-enable
$\overline{\text{AAWE}}/$ $\overline{\text{ASDWE}}/$ $\overline{\text{ASWE}}$	K26	O/Z	IPU	EMIFA asynchronous memory write-enable/SDRAM write-enable/programmable synchronous interface write-enable
ASDCKE	L25	O/Z	IPU	EMIFA SDRAM clock-enable (used for self-refresh mode). If SDRAM is not in system, ASDCKE can be used as a general-purpose output.
$\overline{\text{ASOE3}}$	R22	O/Z	IPU	EMIFA synchronous memory output-enable for $\overline{\text{ACE3}}$ (for glueless FIFO interface)
AARDY	L22	I	IPU	Asynchronous memory ready input

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
EMIFA (64-bit) – ADDRESS				
AEA22	U23	O/Z	IPD	EMIFA external address (doubleword address) EMIFA address numbering for the DM643 device starts with AEA3 to maintain signal name compatibility with other C64x™ devices (e.g., C6414, C6415, and C6416) [see the 64-bit EMIF addressing scheme in the <i>TMS320C6000 DSP External Memory Interface (EMIF) Reference Guide</i> (literature number SPRU266)]. Note: If a configuration pin must be routed out from the device, the internal pullup/pulldown (IPU/IPD) resistor should not be relied upon; TI recommends the use of an external pullup/pulldown resistor. Boot Configuration: - Controls initialization of DSP modes at reset (I) via pullup/pulldown resistors - Boot mode (AEA[22:21]): 00 - No boot (default mode) 01 - HPI boot 10 - Reserved 11 - EMIFA 8-bit ROM boot - EMIF clock select AEA[20:19]: - Clock mode select for EMIFA (AECLKIN_SEL[1:0]) 00 - AECLKIN (default mode) 01 - CPU/4 Clock Rate 10 - CPU/6 Clock Rate 11 - Reserved For more details, see the Device Configurations section of this data sheet.
AEA21	V24			
AEA20	V25			
AEA19	V26			
AEA18	V23			
AEA17	U24			
AEA16	U25			
AEA15	U26			
AEA14	T24			
AEA13	T25			
AEA12	R23			
AEA11	R24			
AEA10	P23			
AEA9	P24			
AEA8	P26			
AEA7	N23			
AEA6	N24			
AEA5	N26			
AEA4	M23			
AEA3	M24			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
EMIFA (64-bit) – DATA				
AED63	AF24	I/O/Z	IPU	EMIFA external data
AED62	AF23			
AED61	AE23			
AED60	AD23			
AED59	AD22			
AED58	AE22			
AED57	AD21			
AED56	AE21			
AED55	AC21			
AED54	AF21			
AED53	AD20			
AED52	AE20			
AED51	AC20			
AED50	AF20			
AED49	AC19			
AED48	AD19			
AED47	W23			
AED46	Y26			
AED45	Y23			
AED44	Y25			
AED43	Y24			
AED42	AA26			
AED41	AA23			
AED40	AA25			
AED39	AA24			
AED38	AB23			
AED37	AB25			
AED36	AB24			
AED35	AC26			
AED34	AC25			
AED33	AD25			
AED32	AD26			
AED31	C26			
AED30	C25			
AED29	D26			
AED28	D25			
AED27	E24			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
AED19	G23	I/O/Z	IPU	EMIFA external data
AED18	G26			
AED17	H23			
AED16	H24			
AED15	C19			
AED14	D19			
AED13	A20			
AED12	D20			
AED11	B20			
AED10	C20			
AED9	A21			
AED8	D21			
AED7	B21			
AED6	C21			
AED5	A23			
AED4	C22			
AED3	B22			
AED2	B23			
AED1	A24			
AED0	B24			
MANAGEMENT DATA INPUT/OUTPUT (MDIO)				
MDCLK	R5	I/O/Z	IPD	MDIO serial clock input/output (I/O/Z).
MDIO	P5	I/O/Z	IPU	MDIO serial data input/output (I/O/Z).
VCXO INTERPOLATED CONTROL PORT (VIC)				
VDAC/GP0[8] ⁽³⁾	AD1	I/O/Z	IPD	VCXO Interpolated Control Port (VIC) single-bit digital-to-analog converter (VDAC) output [output only] [default] or this pin can be programmed as a GP0 8 pin (I/O/Z)
VIDEO PORTS (VP1 AND VP2)				
STCLK	AC1	I	IPD	The STCLK signal drives the hardware counter on the video ports.

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
VIDEO PORT 2 (VP2)				
VP2D[19]	E13	I/O/Z	IPD	Video port 2 (VP2) data input/output (I/O/Z) Note: By default, no function is enabled upon reset. To configure these pins, see the Device Configuration section of this data sheet.
VP2D[18]	E12			
VP2D[17]	D12			
VP2D[16]	C12			
VP2D[15]	B12			
VP2D[14]	E11			
VP2D[13]	D11			
VP2D[12]	C11			
VP2D[11]	B11			
VP2D[10]	A11			
VP2D[9]	D10			
VP2D[8]	C10			
VP2D[7]	B10			
VP2D[6]	A10			
VP2D[5]	D9			
VP2D[4]	C9			
VP2D[3]	B9			
VP2D[2]	A9			
VP2D[1]	D8			
VP2D[0]	C8			
VP2CLK1	A13	I/O/Z	IPD	VP2 clock 1 (I/O/Z)
VP2CLK0	A7	I	IPD	VP2 clock 0 (I)
VP2CTL2	C7	I/O/Z	IPD	VP2 control 2 (I/O/Z)
VP2CTL1	D7			VP2 control 1 (I/O/Z)
VP2CTL0	B8			VP2 control 0 (I/O/Z)

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
VIDEO PORT 1 (VP1) OR McASP0 DATA				
VP1D[19]/AXR0[7] ⁽³⁾	AB12	I/O/Z	IPD	Video port 1 (VP1) data input/output (I/O/Z) or McASP0 data pins (I/O/Z) By default, standalone VP1 data input/output pins have no function enabled upon reset. To configure these pins, see the Device Configuration section of this data sheet. For more details on the McASP0 data pin functions, see <i>McASP0 data</i> section of this table and the Device Configurations section of this data sheet.
VP1D[18]/AXR0[6] ⁽³⁾	AB11			
VP1D[17]/AXR0[5] ⁽³⁾	AC11			
VP1D[16]/AXR0[4] ⁽³⁾	AD11			
VP1D[15]/AXR0[3] ⁽³⁾	AE11			
VP1D[14]/AXR0[2] ⁽³⁾	AC10			
VP1D[13]/AXR0[1] ⁽³⁾	AD10			
VP1D[12]/AXR0[0] ⁽³⁾	AC9			
VP1D[11]	AD9			
VP1D[10]	AE9			
VP1D[9]	AC8			
VP1D[8]	AD8			
VP1D[7]	AC7			
VP1D[6]	AD7			
VP1D[5]	AE7			
VP1D[4]	AC6			
VP1D[3]	AD6			
VP1D[2]	AE6			
VP1D[1]	AF6			
VP1D[0]	AF5			
VP1CLK1	AF10	I/O/Z	IPD	VP1 clock 1 (I/O/Z)
VP1CLK0	AF8	I	IPD	VP1 clock 0 (I)
VP1CTL2	AD5	I/O/Z	IPD	VP1 control 2 (I/O/Z)
VP1CTL1	AE5			VP1 control 1 (I/O/Z)
VP1CTL0	AF4			VP1 control 0 (I/O/Z)
TIMER 2				
–				No external pins. The timer 2 peripheral pins are not pinned out as external pins.
TIMER 1				

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
INTER-INTEGRATED CIRCUIT 0 (I2C0)				
SCL0	E4	I/O/Z	—	I2C0 clock.
SDA0	D3	I/O/Z	—	I2C0 data.
MULTICHANNEL BUFFERED SERIAL PORT 0 (McBSP0)				
CLKR0	AE15	I/O/Z	IPD	McBSP0 receive clock (I/O/Z)
FSR0	AB16	I/O/Z	IPD	McBSP0 receive frame sync (I/O/Z)
DR0	AC16	I	IPD	McBSP0 receive data (I)
DX0	AE16	O/Z	IPD	McBSP0 transmit data (O/Z)
FSX0	AF16	I/O/Z	IPD	McBSP0 transmit frame sync (I/O/Z)
CLKX0	AF17	I/O/Z	IPD	McBSP0 transmit clock (I/O/Z)
ETHERNET MAC (EMAC)				
HD31/MRCLK ⁽³⁾	G1	I		Host-port data (I/O/Z) [default] or EMAC transmit/receive or control pins (I) (O/Z) HPI pin functions are default, see the Device Configurations section of this data sheet. EMAC Media Independent I/F (MII) data, clocks, and control pins for Transmit/Receive. - MII transmit clock (MTCLK), Transmit clock source from the attached PHY. - MII transmit data (MTXD[3:0]), Transmit data nibble synchronous with transmit clock (MTCLK). - MII transmit enable (MTXEN), This signal indicates a valid transmit data on the transmit data pins (MTDX[3:0]). - MII collision sense (MCOL) Assertion of this signal during half-duplex operation indicates network collision. During full-duplex operation, transmission of new frames will not begin if this pin is asserted. - MII carrier sense (MCRS) Indicates a frame carrier signal is being received. - MII receive data (MRXD[3:0]), Receive data nibble synchronous with receive clock (MRCLK). - MII receive clock (MRCLK), Receive clock source from the attached PHY. - MII receive data valid (MRXDV), This signal indicates a valid data nibble on the receive data pins (MRDX[3:0]) and - MII receive error (MRXER), Indicates reception of a coding error on the receive data.
HD30/MCRS ⁽³⁾	H3	I		
HD29/MRXER ⁽³⁾	G2	I		
HD28/MRXDV ⁽³⁾	J4	I		
HD27/MRDX3 ⁽³⁾	H2	I		
HD26/MRDX2 ⁽³⁾	J3	I		
HD25/MRDX1 ⁽³⁾	J1	I		
HD24/MRDX0 ⁽³⁾	K4	I		
HD22/MTCLK ⁽³⁾	L4	I		
HD21/MCOL ⁽³⁾	K2	I		
HD20/MTXEN ⁽³⁾	L3	O/Z		

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
MULTICHANNEL AUDIO SERIAL PORT 0 (McASP0) CONTROL				
AHCLKX0	AC12	I/O/Z	IPD	McASP0 transmit high-frequency master clock (I/O/Z).
AFSX0	AD12	I/O/Z	IPD	McASP0 transmit frame sync or left/right clock (LRCLK) (I/O/Z).
ACLKX0	AB13	I/O/Z	IPD	McASP0 transmit bit clock (I/O/Z).
AMUTE0	AC13	O/Z	IPD	McASP0 mute output (O/Z).
AMUTEIN0	AD13	I/O/Z	IPD	McASP0 mute input (I/O/Z).
AHCLKR0	AB14	I/O/Z	IPD	McASP0 receive high-frequency master clock (I/O/Z).
AFSR0	AC14	I/O/Z	IPD	McASP0 receive frame sync or left/right clock (LRCLK) (I/O/Z).
ACLKR0	AD14	I/O/Z	IPD	McASP0 receive bit clock (I/O/Z).
MULTICHANNEL AUDIO SERIAL PORT 0 (McASP0) DATA				
VP1D[19]/AXR0[7] ⁽³⁾	AB12	I/O/Z	IPD	VP1 input/output data pins [19:12] (I/O/Z) or McASP0 TX/RX data pins [7:0] (I/O/Z) [default].
VP1D[18]/AXR0[6] ⁽³⁾	AB11			
VP1D[17]/AXR0[5] ⁽³⁾	AC11			
VP1D[16]/AXR0[4] ⁽³⁾	AD11			
VP1D[15]/AXR0[3] ⁽³⁾	AE11			
VP1D[14]/AXR0[2] ⁽³⁾	AC10			
VP1D[13]/AXR0[1] ⁽³⁾	AD10			
VP1D[12]/AXR0[0] ⁽³⁾	AC9			
RESERVED FOR TEST				
RSV07	H7	A	—	Reserved. This pin must be connected directly to CV _{DD} for proper operation.
RSV08	R6	A	—	Reserved. This pin must be connected directly to DV _{DD} for proper operation.
RSV05	E14	I	IPD	Reserved (leave unconnected, do not connect to power or ground. If the signal must be routed out from the device, the internal pull-up/down resistance should not be relied upon and an external pull-up/down should be used.)
RSV06	W7	A	—	
RSV00	AA3	A	—	
RSV01	AB3	I	—	
RSV02	AC4	O/Z	—	
RSV03	AD3	O/Z	—	

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
SUPPLY VOLTAGE PINS				
DV _{DD}	A2	S		3.3-V supply voltage (see the Power-Supply Decoupling section of this data sheet)
	A25			
	B1			
	B2			
	B14			
	B25			
	B26			
	C3			
	C24			
	D4			
	D23			
	E5			
	E7			
	E8			
	E10			
	E17			
	E19			
	E20			
	E22			
	F9			
	F12			
	F15			
	F18			
	G5			
	G22			
	H5			
	H22			
	J6			
	J21			
	K5			
	K22			
	M6			
	M21			
	N2			
	P25			
	R21			
	U5			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME		NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
DV _{DD}		AA9	S		3.3-V supply voltage (see the Power-Supply Decoupling section of this data sheet)
		AA12			
		AA15			
		AA18			
		AB5			
		AB7			
		AB8			
		AB10			
		AB17			
		AB19			
		AB20			
		AB22			
		AC23			
		AD24			
		AE1			
		AE2			
		AE13			
		AE25			
		AE26			
		AF2			
		AF25			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
CV _{DD}	F6	S		1.2-V supply voltage (-500 device) 1.4 V supply voltage (-600 device) (see the Power-Supply Decoupling section of this data sheet)
	F7			
	F20			
	F21			
	G6			
	G7			
	G8			
	G10			
	G11			
	G13			
	G14			
	G16			
	G17			
	G19			
	G20			
	G21			
	H20			
	K7			
	K20			
	L7			
	L20			
	M12			
	M14			
	N7			
	N13			
	N15			
	N20			
	P7			
	P12			
	P14			
	P20			
	R13			
	R15			
	T7			
	T20			
	U7			
	U20			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME		NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
CV _{DD}		Y16	S		1.2-V supply voltage (-500 device) 1.4 V supply voltage (-600 device) (see the Power-Supply Decoupling section of this data sheet)
		Y17			
		Y19			
		Y20			
		Y21			
		AA6			
		AA7			
		AA20			
		AA21			
GROUND PINS					
V _{SS}		A1	GND		Ground pins
		A3			
		A6			
		A8			
		A12			
		A14			
		A19			
		A22			
		A26			
		B3			
		B6			
		B7			
		B13			
		B19			
		C2			
		C4			
		C13			
		C18			
		C23			
		D1			
		D2			
		D5			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
V _{SS}	F8	GND		Ground pins
	F10			
	F11			
	F13			
	F14			
	F16			
	F17			
	F19			
	F22			
	G9			
	G12			
	G15			
	G18			
	H1			
	H6			
	H21			
	H26			
	J5			
	J7			
	J20			
	J22			
	K6			
	K21			
	L1			
	L6			
	L21			
	M7			
	M13			
	M15			
	M20			
	N5			
	N6			
	N12			
	N14			
	N21			
	N25			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME	NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
V _{SS}	T1	GND		Ground pins
	T5			
	T6			
	T21			
	T26			
	U6			
	U21			
	V5			
	V7			
	V20			
	V22			
	W1			
	W6			
	W21			
	W26			
	Y9			
	Y12			
	Y15			
	Y18			
	AA4			
	AA5			
	AA8			
	AA10			
	AA11			
	AA13			
	AA14			
	AA16			
	AA17			
	AA19			
	AA22			
	AB1			
	AB2			
	AB4			
	AB6			
	AB9			
	AB18			

Table 2-4. Terminal Functions (continued)

SIGNAL NAME		NO.	TYPE ⁽¹⁾	IPD/ IPU ⁽²⁾	DESCRIPTION
V _{SS}		AD18	GND		Ground pins
		AE3			
		AE8			
		AE10			
		AE12			
		AE14			
		AE19			
		AE24			
		AF1			
		AF7			
		AF9			
		AF11			
		AF13			
		AF15			
		AF19			
		AF22			
		AF26			

2.6 Development

2.6.1 Development Support

TI offers an extensive line of development tools for the TMS320C6000™ DSP platform, including tools to evaluate the performance of the processors, generate code, develop algorithm implementations, and fully integrate and debug software and hardware modules.

The following products support development of C6000™ DSP-based applications:

Software Development Tools:

Code Composer Studio™ Integrated Development Environment (IDE): including Editor

C/C++/Assembly Code Generation, and Debug plus additional development tools

Scalable, Real-Time Foundation Software (DSP/BIOS™), which provides the basic run-time target software needed to support any DSP application.

Hardware Development Tools:

Extended Development System (XDS™) Emulator (supports C6000™ DSP multiprocessor system debug)
EVM (Evaluation Module)

For a complete listing of development-support tools for the TMS320C6000™ DSP platform, visit the Texas Instruments web site on the Worldwide Web at <http://www.ti.com> uniform resource locator (URL). For information on pricing and availability, contact the nearest TI field sales office or authorized distributor.

2.6.2 Device Support

2.6.2.1 Device and Development-Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all DSP devices and support tools. Each DSP commercial family member has one of three prefixes: TMX, TMP, or TMS (e.g., **TMS320DM643GDK500**). Texas Instruments recommends two of three possible prefix designators for its support tools: TMDX and TMDS. These prefixes represent evolutionary stages of product development from engineering prototypes (TMX/TMDX) through fully qualified production devices/tools (TMS/TMDS).

Device development evolutionary flow:

TMX	Experimental device that is not necessarily representative of the final device's electrical specifications
TMP	Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification
TMS	Fully qualified production device

Support tool development evolutionary flow:

TMDX	Development-support product that has not yet completed Texas Instruments internal qualification testing.
TMDS	Fully qualified development-support product

TMX and TMP devices and TMDX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

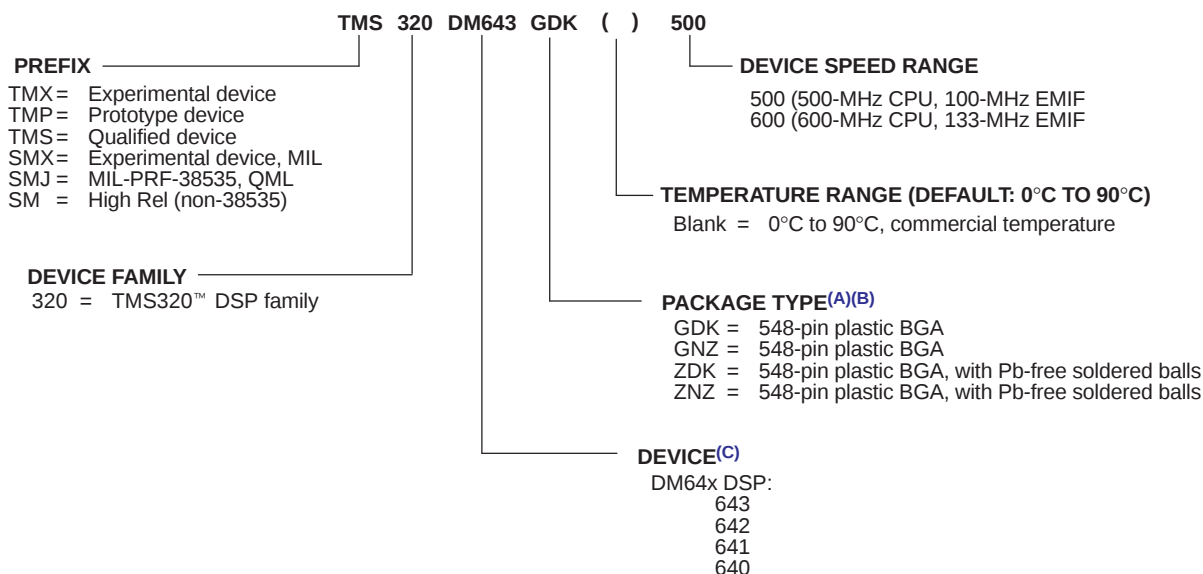
TMS devices and TMDS development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX or TMP) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the package type (for example, GDK), the temperature range (for example, “blank” is the default commercial temperature range), and the device speed range in megahertz (for example, 500 is 500 MHz). [Figure 2-15](#) provides a legend for reading the complete device name for any TMS320C6000™ DSP platform member.

The ZDK package, like the GDK package, is a 548-ball plastic BGA *only* with Pb-free balls. The ZNZ is the Pb-free package version of the GNZ package.

For device part numbers and further ordering information for TMS320DM643 in the GDK, GNZ, ZDK, and ZNZ package types, see the TI website (<http://www.ti.com>) or contact your TI sales representative.



- A. BGA = Ball Grid Array
- B. The ZDK and ZNZ mechanical package designators represent the version of the GDK and GLZ packages, respectively, with Pb-free balls. For more detailed information, see the *Mechanical Data* section of this document.
- C. For actual device part numbers (P/Ns) and ordering information, see the TI website (www.ti.com).

Figure 2-15. TMS320DM64x™ DSP Device Nomenclature (Including the TMS320DM643 Device)

2.6.2.2 Documentation Support

Extensive documentation supports all TMS320™ DSP family generations of devices from product announcement through applications development. The types of documentation available include: data sheets, such as this document, with design specifications; complete user's reference guides for all devices and tools; technical briefs; development-support tools; on-line help; and hardware and software applications. The following is a brief, descriptive list of support documentation specific to the C6000™ DSP devices:

The *TMS320C6000 CPU and Instruction Set Reference Guide* (literature number SPRU189) describes the C6000™ DSP CPU (core) architecture, instruction set, pipeline, and associated interrupts.

The *TMS320C6000 DSP Peripherals Overview Reference Guide* (literature number SPRU190) provides an overview and briefly describes the functionality of the peripherals available on the C6000™ DSP platform of devices. This document also includes a table listing the peripherals available on the C6000 devices along with literature numbers and hyperlinks to the associated peripheral documents.

The *TMS320C64x Technical Overview* (literature number SPRU395) gives an introduction to the C64x™ digital signal processor, and discusses the application areas that are enhanced by the C64x™ DSP VelociTI.2™ VLIW architecture.

The *TMS320C64x DSP Video Port/VCXO Interpolated Control (VIC) Port Reference Guide* (literature number SPRU629) describes the functionality of the Video Port and VIC Port peripherals.

The *TMS320C6000 DSP Multichannel Audio Serial Port (McASP) Reference Guide* (literature number SPRU041) describes the functionality of the McASP peripheral.

TMS320C6000 DSP Inter-Integrated Circuit (I2C) Module Reference Guide (literature number SPRU175) describes the functionality of the I²C peripheral.

TMS320C6000 DSP Ethernet Media Access Controller (EMAC)/ Management Data Input/Output (MDIO) Module Reference Guide (literature number SPRU628) describes the functionality of the EMAC and MDIO peripherals.

The *Using IBIS Models for Timing Analysis* application report (literature number SPRA839) describes how to properly use IBIS models to attain accurate timing analysis for a given system.

The tools support documentation is electronically available within the Code Composer Studio™ Integrated Development Environment (IDE). For a complete listing of C6000™ DSP latest documentation, visit the Texas Instruments web site on the Worldwide Web at <http://www.ti.com> uniform resource locator (URL).

2.6.2.3 Device Silicon Revision

This data manual supports the initial release of the DM643 device; therefore, no device-specific silicon errata document is currently available.

3 Device Configurations

On the DM643 device, bootmode and certain device configurations/peripheral selections are determined at device reset, while other device configurations/peripheral selections are software-configurable via the peripheral configurations register (PERCFG) [address location 0x01B3F000] after device reset.

3.1 Configurations at Reset

For proper DM643 device operation, the following external pins must be configured correctly:

- The GP0[0] (pin M5) **must** remain low, **do not** oppose the internal pulldown (IPD).
- The RSV09 (pin E2) at device reset **must be** pulled down via a 10-kΩ resistor.

3.1.1 Peripheral Selection at Device Reset

Some DM643 peripherals share the same pins (internally muxed) and are mutually exclusive (i.e., HPI, EMAC, and MDIO). Other DM643 peripherals (i.e., the Timers, I2C0, GP0, McBSP0, and VP2), are always available.

- HPI, EMAC, and MDIO peripherals

The MAC_EN pin is latched at reset and determines specific peripheral selection, summarized in [Table 3-1](#). For further clarification of the HPI vs. EMAC configuration, see [Table 3-2](#).

Table 3-1. HD5, and MAC_EN Peripheral Selection (HPI, EMAC, and MDIO)

PERIPHERAL SELECTION		PERIPHERALS SELECTED		
HD5 Pin [Y1]	MAC_EN Pin [C5]	HPI Data Lower	HPI Data Upper	EMAC and MDIO
0	0	√	Hi-Z	Disabled
0	1	√	Hi-Z	√
1	0	√	√	Disabled
1	1	Disabled		√

- The HPI peripheral is enabled and based on the HD5 and MAC_EN pin configuration at reset, HPI16 mode or EMAC and MDIO can be selected.
- The MAC_EN pin, in combination with the HD5 pin, controls the selection of the EMAC and MDIO peripherals (for more details, see [Table 3-2](#)).

Table 3-2. HPI vs. EMAC Peripheral Pin Selection

CONFIGURATION SELECTION			PERIPHERALS SELECTED	
GP0[0] (Pin [M5]) ⁽¹⁾	HD5 (Pin [Y1])	MAC_EN (Pin [C5])	HD[15:0]	HD[31:16]
0	0	0	HPI16	Hi-Z
0	0	1	HPI16	used for EMAC
0	1	0	HPI32 (HD[31:0])	

Table 3-3. DM643 Device Configuration Pins (TOUT1/LENDIAN, AEA[22:19], HD5, and MAC_EN)

CONFIGURATION PIN	NO.	FUNCTIONAL DESCRIPTION
TOUT1/LENDIAN	B5	Device Endian mode (LEND) 0 - System operates in Big Endian mode 1 - System operates in Little Endian mode (default)
AEA[22:21]	[U23, V24]	Bootmode [1:0] 00 - No boot (default mode) 01 - HPI boot 10 - Reserved 11 - EMIFA 8-bit ROM boot
AEA[20:19]	[V25, V26]	EMIFA input clock select Clock mode select for EMIFA (AECLKIN_SEL[1:0]) 00 - AECLKIN (default mode) 01 - CPU/4 Clock Rate 10 - CPU/6 Clock Rate 11 - Reserved
HD5	Y1	HPI peripheral bus width (HPI_WIDTH) 0 - HPI operates as an HPI16. (HPI bus is 16 bits wide. HD[15:0] pins are used and the remaining HD[31:16] pins are reserved pins in the Hi-Z state.) 1 - HPI operates as an HPI32. (HPI bus is 32 bits wide. All HD[31:0] pins are used for host-port operations.) (Also see the TOUT0/MAC_EN functional description in this table)
TOUT0/MAC_EN	C5	Peripheral Selection 0 - EMAC and MDIO disabled; HPI16 enabled (default mode) [HPI32, if HD5 = 1; HPI16 if HD5 = 0] 1 - EMAC and MDIO enabled; HPI16 enabled, if HD5 = 0; HPI32 disabled, if HD5 = 1

3.2 Configurations After Reset

3.2.1 Peripheral Selection After Device Reset

Video Ports, McBSP0, McASP0 and I2C0

The DM643 device has designated registers for peripheral configuration (PERCFG), device status (DEVSTAT), and JTAG identification (JTAGID). These registers are part of the Device Configuration module and are mapped to a 4K block memory starting at 0x01B3F000. The CPU accesses these registers via the CFGBUS.

The peripheral configuration register (PERCFG), allows the user to control the peripheral selection of the Video Ports (VP1 and VP2) McBSP0, McASP0, and I2C0 peripherals. For more detailed information on the PERCFG register control bits, see [Figure 3-1](#) and [Table 3-4](#).

31	Reserved							24
R-0								
23	Reserved							16
R-0								
15	Reserved							8
R-0								
7	6	5	4	3	2	1	0	
Reserved	VP2EN	VP1EN	Reserved	I2C0EN	MCBSP1EN ⁽¹⁾	MCBSP0EN	MCASP0EN	
R-0	R/W-0	R/W-0	R-0	R/W-0	R/W-1	R/W-1	R/W-0	

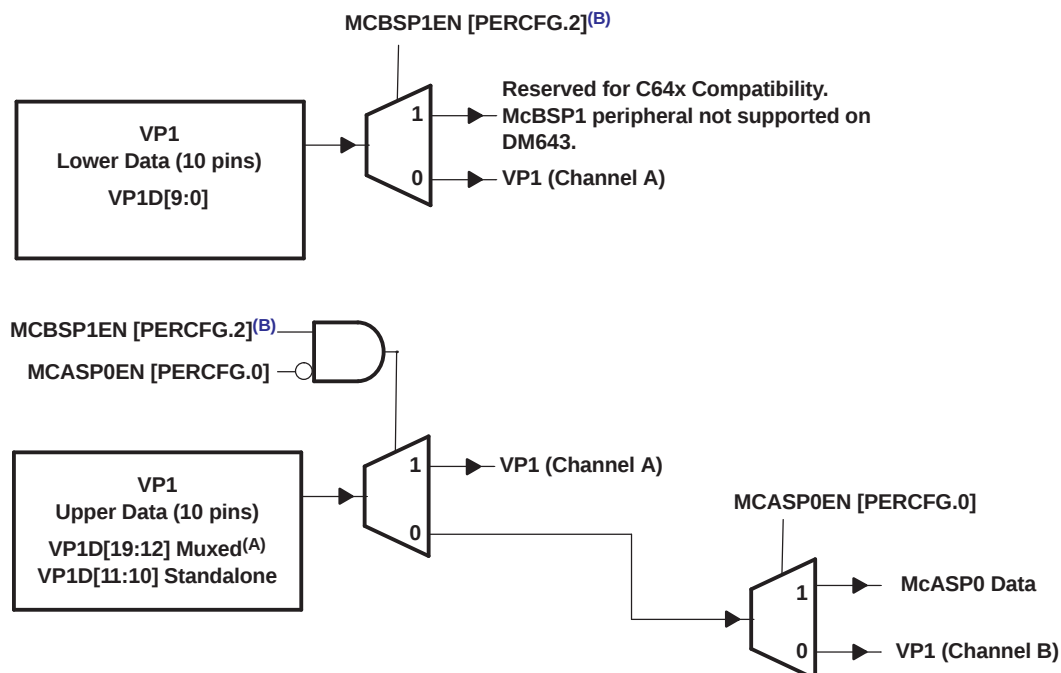
Legend: R = Read only, R/W = Read/Write, -n = value after reset

(1) The DM643 device **does not** support the McBSP1 peripheral.

**Figure 3-1. Peripheral Configuration Register (PERCFG)
[Address Location: 0x01B3F000 - 0x01B3F003]**

Table 3-4. Peripheral Configuration (PERCFG) Register Selection Bit Descriptions

BIT	NAME	DESCRIPTION
31:7	Reserved	Reserved. Read-only, writes have no effect.
6	VP2EN	VP2 Enable bit. Determines whether the VP2 peripheral is enabled or disabled. 0 = VP2 is disabled, the module is powered down (default). (This feature allows power savings by disabling the peripheral when not in use.) 1 = VP2 is enabled.
5	VP1EN	VP1 Enable bit. Determines whether the VP1 peripheral is enabled or disabled. 0 = VP1 is disabled, the module is powered down (default). (This feature allows power savings by disabling the peripheral when not in use.) 1 = VP1 is enabled. Note: For proper DM643 device operation, the MCBSP1EN bit must be set to zero (0).
4	Reserved	Reserved. Read-only, writes have no effect.
3	I2C0EN	Inter-integrated circuit 0 (I2C0) enable bit. Selects whether I2C0 peripheral is enabled or disabled (default). 0 = I2C0 is disabled, the module is powered down (default). 1 = I2C0 is enabled.
2	MCBSP1EN	For C64x compatibility and possible future expansion, at device reset this bit is a one (1). The DM643 device does not support the McBSP1 peripheral. Note: For proper DM643 device operation, this bit must be set to zero (0).
1	MCBSP0EN	McBSP0 Enable bit. Determines whether the McBSP0 peripheral is enabled or disabled. 0 = McBSP0 is disabled, the module is powered down. (This



A. Consists of: VP1D[19:12]/AXR0[7:0]

B. McBSP1 peripheral not supported on DM643. For proper DM643 device operation, the MCBSP1EN bit **must** be set to zero.

Figure 3-2. VP1, McBSP1, McBSP0, and McASP0 Data/Control Pin Muxing

3.3 Peripheral Configuration Lock

By default, the McASP0, VP1, VP2, and I2C peripherals are disabled on power up. In order to use these peripherals on the DM643 device, the peripheral must first be enabled in the Peripheral Configuration register (PERCFG). **Software muxed pins should not be programmed to switch functionalities during run-time. Care should also be taken to ensure that no accesses are being performed before disabling the peripherals.** To help minimize power consumption in the DM643 device, unused peripherals may be disabled.

Figure 3-3 shows the flow needed to enable (or disable) a given peripheral on the DM643 device.

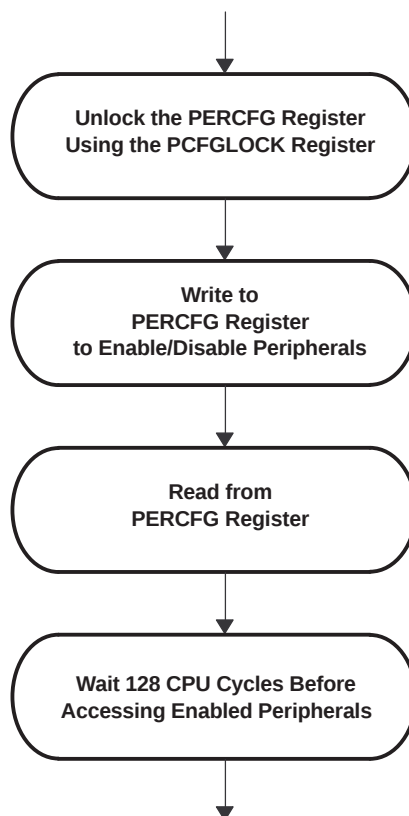


Figure 3-3. Peripheral Enable/Disable Flow Diagram

A 32-bit key (value = 0x10C0010C) must be written to the Peripheral Configuration Lock register (PCFGLOCK) in order to unlock access to the PERCFG register. Reading the PCFGLOCK register determines whether the PERCFG register is currently locked (LOCKSTAT bit = 1) or unlocked (LOCKSTAT bit = 0), see [Figure 3-4](#). A peripheral can only be enabled when the PERCFG register is "unlocked" (LOCKSTAT bit = 0).

Read Accesses

31	1	0
Reserved		LOCKSTAT
R-0		R-1

Write Accesses

31	0
LOCK	
W-0	

Legend: R = Read only, R/W = Read/Write, -n = value after reset

Figure 3-4. PCFGLOCK Register Diagram [Address Location: 0x01B3 F018] - Read/Write Accesses

Table 3-5. PCFGLOCK Register Selection Bit Descriptions - Read Accesses

BIT	NAME	DESCRIPTION
31:1	Reserved	Reserved. Read-only, writes have no effect.
0	LOCKSTAT	Lock status bit. Determines whether the PERCFG register is locked or unlocked. 0 = Unlocked, read accesses to the PERCFG register allowed. 1 = Locked, write accesses to the PERCFG register do not modify the register state [default]. Reads are unaffected by Lock Status.

Table 3-6. PCFGLOCK Register Selection Bit Descriptions - Write Accesses

BIT	NAME	DESCRIPTION
31:0	LOCK	Lock bits. 0x10C0010C = Unlocks PERCFG register accesses.

Any write to the PERCFG register will automatically relock the register. In order to avoid the unnecessary overhead of multiple unlock/enable sequences, all peripherals should be enabled with a single write to the PERCFG register with the necessary enable bits set.

Prior to waiting 128 CPU cycles, the PERCFG register should be read. There is no direct correlation between the CPU issuing a write to the PERCFG register and the write actually occurring. Reading the PERCFG register after the write is issued forces the CPU to wait for the write to the PERCFG register to occur.

Once a peripheral is enabled, the DSP (or other peripherals such as the HPI) must wait a minimum of 12

3.4 Device Status Register Description

The device status register depicts the status of the device peripheral selection. For the actual register bit names and their associated bit field descriptions, see [Figure 3-5](#) and [Table 3-7](#).

31	Reserved																24
R-0																	
23	Reserved																16
R-0																	
15	Reserved								12	11	10	9	8				
R-0								MAC_EN		HPI_WIDTH	Reserved	Reserved					
R-x								R-x		R-x	R-x	R-x					
7	6																

Table 3-7. Device Status (DEVSTAT) Register Selection Bit Descriptions

BIT	NAME	DESCRIPTION
31:12	Reserved	Reserved. Read-only, writes have no effect.
11	MAC_EN	EMAC enable bit. Shows the status of whether EMAC peripheral is enabled or disabled (default). 0 = EMAC is disabled, and the module is powered down (default). 1 = EMAC is enabled.
10	HPI_WIDTH	HPI bus width control bit. Shows the status of whether the HPI bus operates in 32-bit mode or in 16-bit mode (default). 0 = HPI operates in 16-bit mode. (default). 1 = HPI operates in 32-bit mode.
9:7	Reserved	Reserved. Read-only, writes have no effect.
6	CLKMODE1	Clock mode select bits Shows the status of whether the CPU clock frequency equals the input clock frequency X1 (Bypass), x6, or x12. Clock mode select for CPU clock frequency (CLKMODE[1:0])
5	CLKMODE0	00 - Bypass (x1) (default mode) 01 - x6 10 - x12 11 - Reserved For more details on the CLKMODE pins and the PLL multiply factors, see the Clock PLL section of this data sheet.
4	LENDIAN	Device Endian mode (LEND) Shows the status of whether the system is operating in Big Endian mode or Little Endian mode (default). 0 - System is operating in Big Endian mode 1 - System is operating in Little Endian mode (default)
3	BOOTMODE1	Bootmode configuration bits Shows the status of what device bootmode configuration is operational.
2	BOOTMODE0	Bootmode [1:0] 00 - No boot (default mode) 01 - HPI boot 10 - Reserved 11 - EMIFA 8-bit ROM boot
1	AECLKINSEL1	EMIFA input clock select Shows the status of what clock mode is enabled or disabled for the EMIF. Clock mode select for EMIFA (AECLKIN_SEL[1:0])
0	AECLKINSEL0	00 - AECLKIN (default mode) 01 - CPU/4 Clock Rate 10 - CPU/6 Clock Rate 11 - Reserved

3.5 Multiplexed Pin Configurations

Multiplexed pins are pins that are shared by more than one peripheral and are internally multiplexed. Some of these pins are configured by software, and the others are configured by external pullup/pulldown resistors only at reset. Those muxed pins that are configured by software should **not** be programmed to switch functionalities during run-time. Those muxed pins that are configured by external pullup/pulldown resistors are mutually exclusive; only one peripheral has primary control of the function of these pins after reset. [Table 3-8](#) identifies the multiplexed pins on the DM643

Table 3-8. DM643 Device Multiplexed Pin Configurations

MULTIPLEXED PINS NAME NO.		DEFAULT FUNCTION	DEFAULT SETTING	DESCRIPTION
CLKOUT4/GP0[1]	D6	CLKOUT4	GP1EN = 0 (disabled)	These pins are software-configurable. To use these pins as GPIO pins, the GPxEN bits in the GPIO Enable Register and the GPxDIR bits in the GPIO Direction Register must be properly configured. GPxEN = 1: GPx pin enabled GPxDIR = 0: GPx pin is an input GPxDIR = 1: GPx pin is an output
CLKOUT6/GP0[2]	C6	CLKOUT6	GP2EN = 0 (disabled)	
VDAC/GP0[8]	AD1	None	GP8EN = 0 (disabled) MAC_EN = 0 (disabled)	The VDAC output pin function is default. To use GP0[8] as a GPIO pin, the GPxEN bits in the GPIO Enable Register and the GPxDIR bits in the GPIO Direction Register must be properly configured. GP8EN = 1: GP8 pin enabled GP8DIR = 0: GP8 pin is an input GP8DIR = 1: GP8 pin is an output
VP1D[19]/AXR0[7]	AB12	None	VP1EN bit = 0 (disabled) MCASP0EN bit = 0 (disabled)	By default, no function is enabled upon reset. To enable the Video Port 1 data pins, the VP1EN bit in the PERCFG register must be set to a 1. (McASP0 data pins are disabled). To enable the McASP0[7:0] data pins, the MCASP0EN bit in the PERCFG register must be set to a 1. (VP1 upper data pins are disabled).
VP1D[18]/AXR0[6]	AB11			
VP1D[17]/AXR0[5]	AC11			
VP1D[16]/AXR0[4]	AD11			
VP1D[15]/AXR0[3]	AE11			
VP1D[14]/AXR0[2]	AC10			
VP1D[13]/AXR0[1]	AD10			
VP1D[12]/AXR0[0]				

3.6 Debugging Considerations

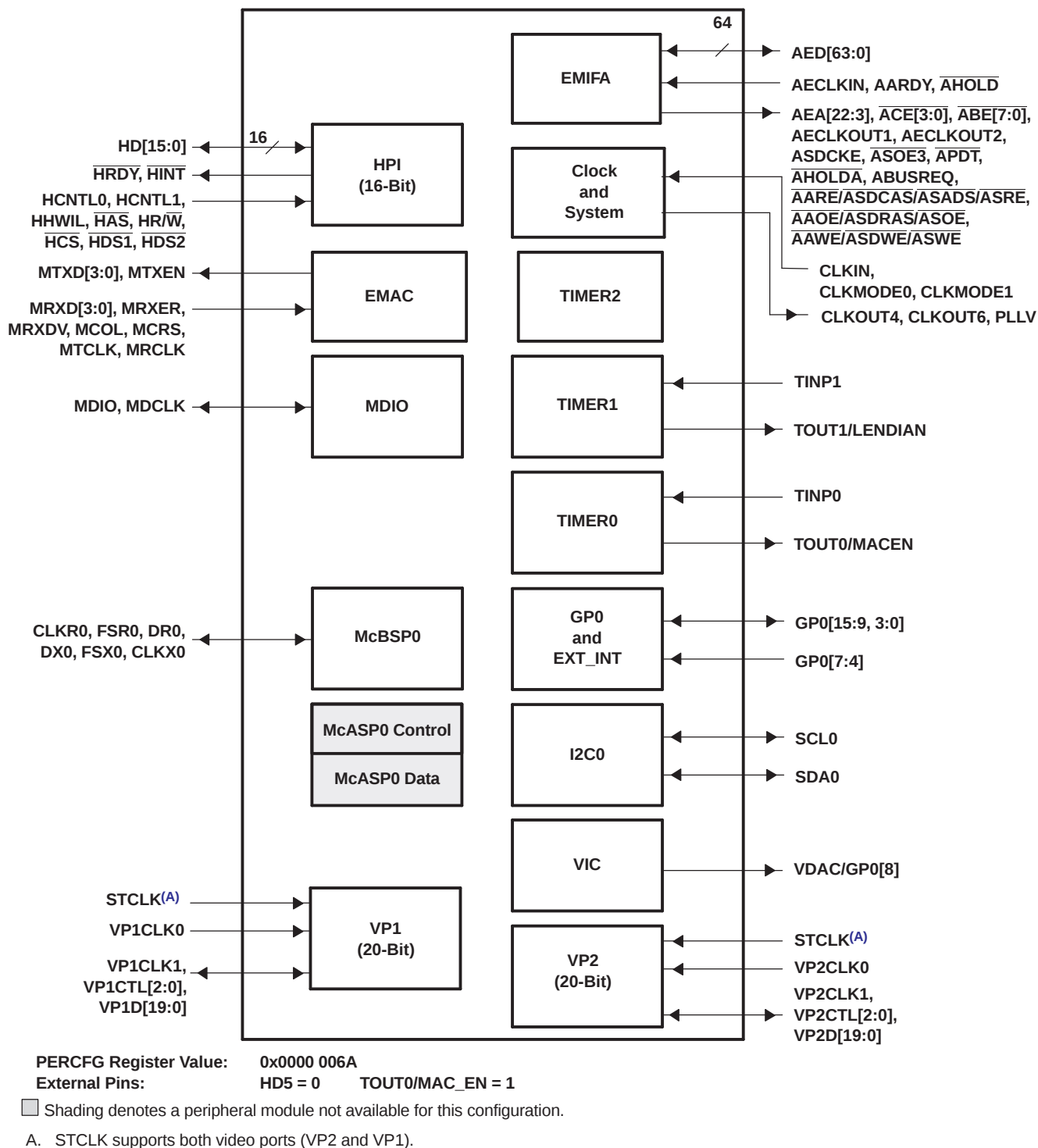
It is recommended that external connections be provided to device configuration pins, including TOUT1/LENDIAN, AEA[22:19], HD5, and TOUT0/MAC_EN. Although internal pullup/pulldown resistors exist on these pins, providing external connectivity adds convenience to the user in debugging and flexibility in switching operating modes.

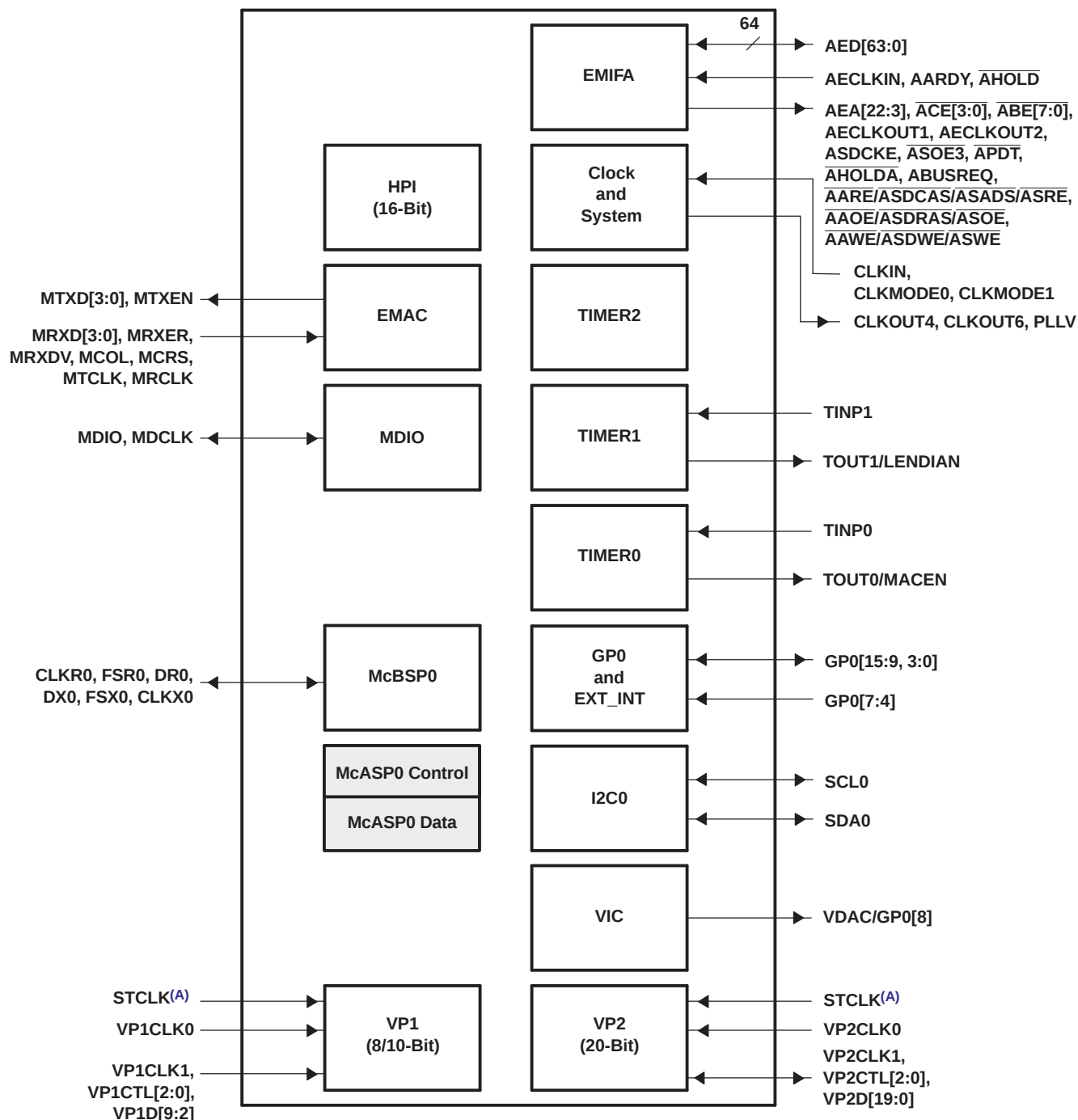
Internal pullup/pulldown resistors also exist on the non-configuration pins on the AEA bus (AEA[18:0]). Do **not** oppose the internal pullup/pulldown resistors on these non-configuration pins with external pullup/pulldown resistors. If an external controller provides signals to these non-configuration pins, these signals must be driven to the default state of the pins at reset, or not be driven at all.

For the internal pullup/pulldown resistors for all device pins, see the terminal functions table.

3.7 Configuration Examples

[Figure 3-6](#) through [Figure 3-8](#) illustrate examples of peripheral selections that are configurable on the DM643 device.

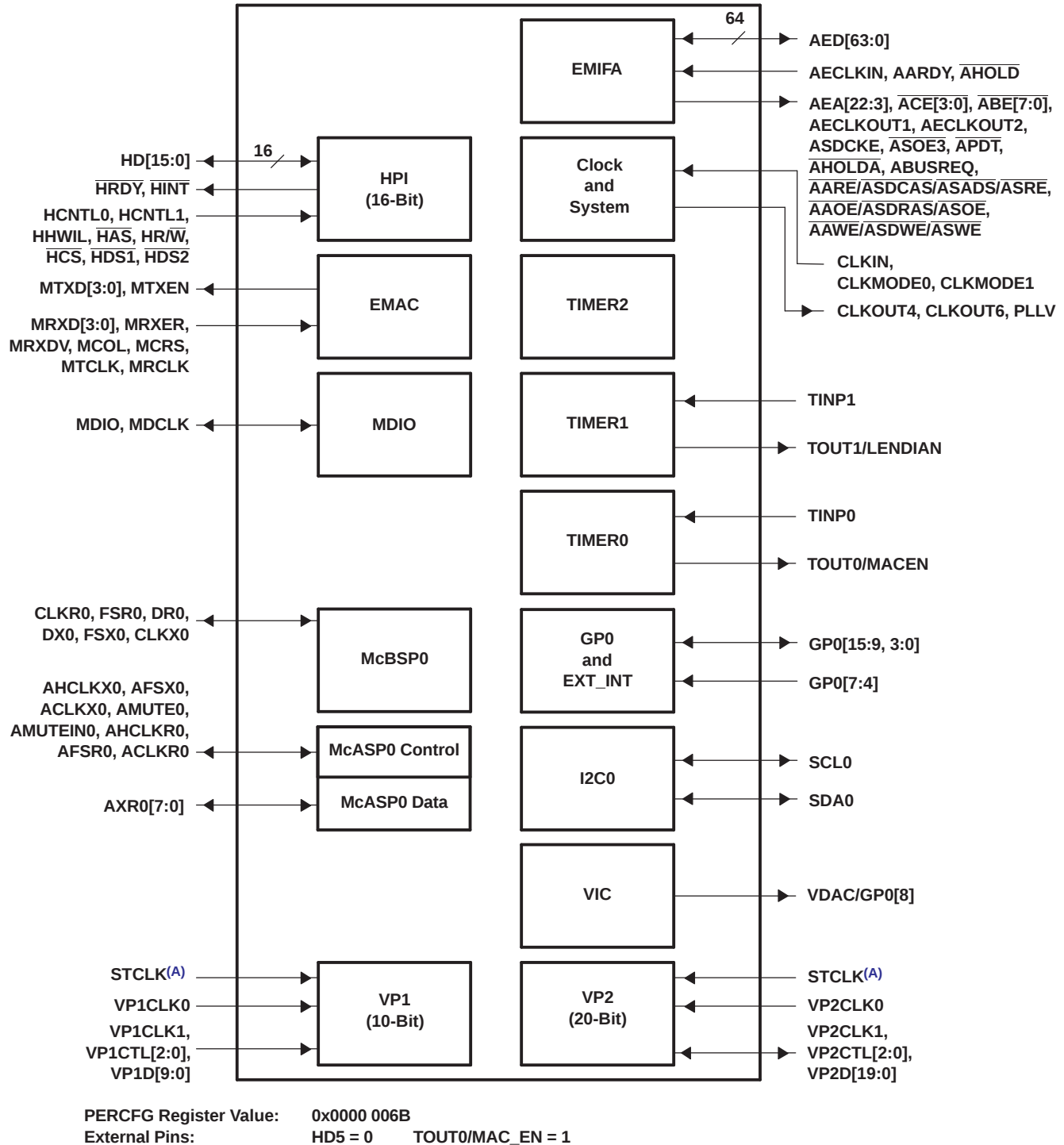




PERCFG Register Value: 0x0000 006B

External Pins: HD5 = 1 TOUT0/MAC_EN = 1

■ Shading denotes a peripheral



4 Device Operating Conditions

4.1 Absolute Maximum Ratings Over Operating Case Temperature Range (Unless Otherwise Noted) ⁽¹⁾

Supply voltage ranges:	CV _{DD} ⁽²⁾	–0.3 V to 1.8 V
	DV _{DD} ⁽²⁾	–0.3 V to 4 V
Input voltage ranges:	V _I	–0.3 V to 4 V
Output voltage ranges:	V _O	–0.3 V to 4 V
Operating case temperature ranges, T _C :	(default)	0°C to 90°C
Storage temperature range, T _{stg} :		–65°C to 150°C
Package Temperature Cycling:	Temperature Range	–40°C to 125°C
	Number of Cycles	500

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to V_{SS}.

4.2 Recommended Operating Conditions

|--|--|--|

4.3 Electrical Characteristics Over Recommended Ranges of Supply Voltage and Operating Case Temperature (Unless Otherwise Noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
V _{OH}	High-level output voltage	DV _{DD} = MIN, I _{OH} = MAX ⁽²⁾	2.4			V
V _{OL}	Low-level output voltage	DV _{DD} = MIN, I _{OL} = MAX ⁽²⁾			0.4	V
I _I	Input current	V _I = V _{SS} to DV _{DD} no opposing internal resistor			±10	uA
		V _I = V _{SS} to DV _{DD} opposing internal pullup resistor ⁽³⁾	50	100	150	uA
		V _I = V _{SS} to DV _{DD} opposing internal pulldown resistor ⁽³⁾	–150	–100	–50	uA
I _{OH}	High-level output current	EMIF, CLKOUT4, CLKOUT6, EMUx			–16	mA
		Video Ports, Timer, TDO, GPIO (Excluding GP0[2:1]), McBSP			–8	mA
		HPI				

